

# Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

- Output Swing Includes Both Supply Rails
- Extended Common-Mode Input Voltage Range . . . 0 V to 4.25 V (Min) at 5-V Single Supply
- No Phase Inversion
- Low Noise . . . 16 nV/√Hz Typ at f = 1 kHz
- Low Input Offset Voltage  
950 μV Max at T<sub>A</sub> = 25°C (TLV244xA)
- Low Input Bias Current . . . 1 pA Typ
- 600-Ω Output Drive
- High-Gain Bandwidth . . . 1.8 MHz Typ
- Low Supply Current . . . 750 μA Per Channel Typ
- Macromodel Included
- Available in Q-Temp Automotive HighRel Automotive Applications Configuration Control / Print Support Qualification to Automotive Standards

## description

The TLV244x and TLV244xA are low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range of these devices has been extended over typical standard CMOS amplifiers, making them suitable for a wide range of applications. In addition, these devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. Both devices offer comparable ac performance while having lower noise, input offset voltage, and power dissipation than existing CMOS operational amplifiers. The TLV244x has increased output drive over previous rail-to-rail operational amplifiers and can drive 600-Ω loads for telecommunications applications.

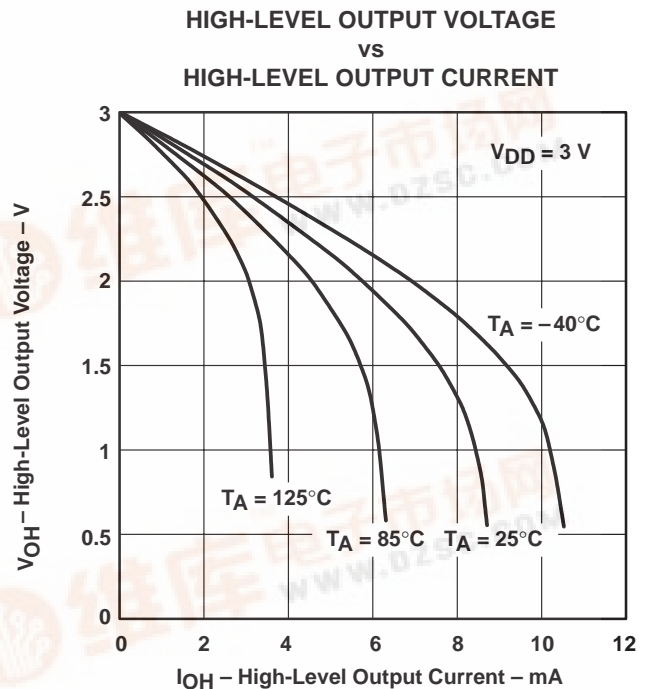


Figure 1

The other members in the TLV244x family are the low-power, TLV243x, and micro-power, TLV2422, versions.

The TLV244x, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV244xA is available with a maximum input offset voltage of 950 μV.

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption make them ideal for high density, battery-powered equipment.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Advanced LinCMOS is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 1999, Texas Instruments Incorporated  
On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# TLV2442, TLV2442A, TLV2444, TLV2444A

## Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT

### WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

#### TLV2442 AVAILABLE OPTIONS

T <sub>A</sub>	V <sub>IO</sub> max AT 25°C	PACKAGED DEVICES				
		SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	TSSOP (PW)	CERAMIC FLAT PACK (U)
0°C to 70°C	2.5 mV	TLV2442CD	—	—	TLV2442CPW	—
–40°C to 85°C	950 μV 2.5 mV	TLV2442AID TLV2442ID	— —	— —	TLV2442AIPW —	— —
–40°C to 125°C	950 μV 2.5 mV	TLV2442AQD TLV2442QD	— —	— —	— —	— —
–55°C to 125°C	950 μV 2.5 mV	— —	TLV2442AMFK TLV2442MFK	TLV2442AMJG TLV2442MJG	— —	TLV2442AMU TLV2442MU

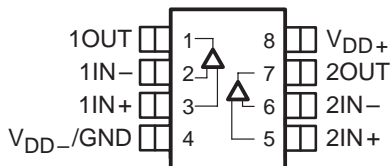
The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2442CDR).

#### TLV2444 AVAILABLE OPTIONS

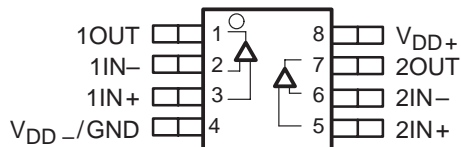
T <sub>A</sub>	V <sub>IO</sub> max AT 25°C	PACKAGED DEVICES	
		SMALL OUTLINE (D)	TSSOP (PW)
0°C to 70°C	2.5 mV	TLV2444CD	TLV2444CPW
–40°C to 125°C	950 μV 2.5 mV	TLV2444AID TLV2444ID	TLV2444AIPW TLV2444IPW

The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2444CDR).

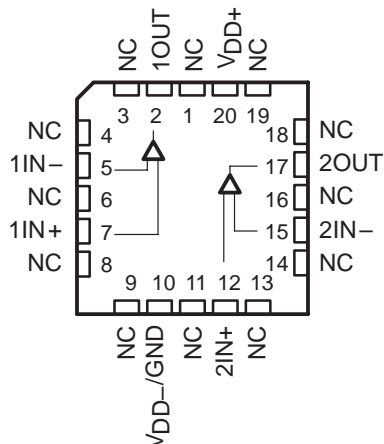
**TLV2442  
D OR JG PACKAGE  
(TOP VIEW)**



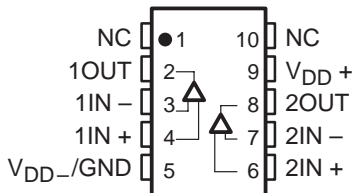
**TLV2442  
PW PACKAGE  
(TOP VIEW)**



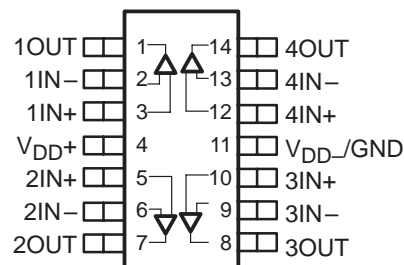
**TLV2442  
FK PACKAGE  
(TOP VIEW)**



**TLV2442  
U PACKAGE  
(TOP VIEW)**



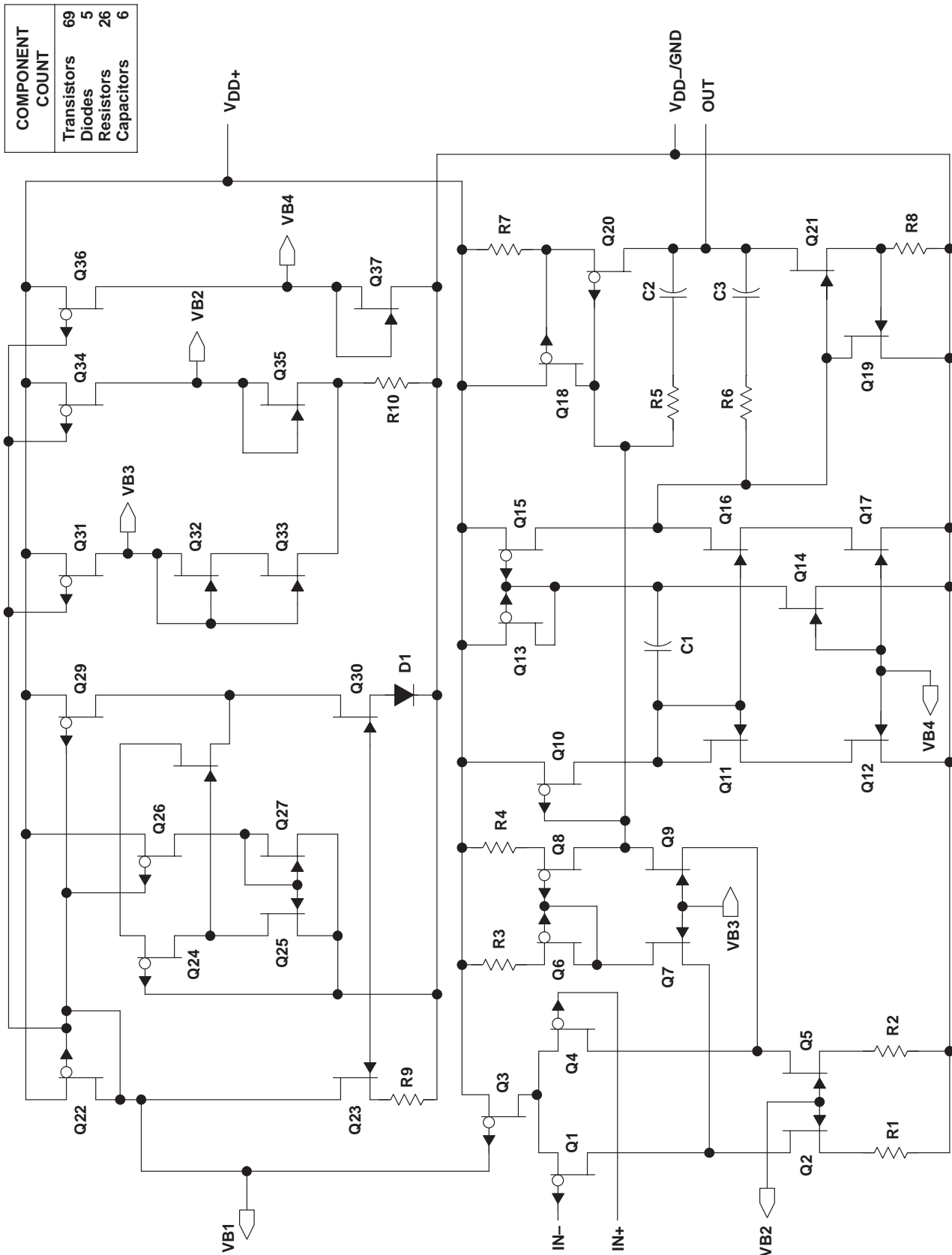
**TLV2444  
D OR PW PACKAGE  
(TOP VIEW)**



NC – No internal connection

TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

equivalent schematic (each amplifier)



COMPONENT COUNT	
Transistors	69
Diodes	5
Resistors	26
Capacitors	6

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{DD}$ (see Note 1)	12 V
Differential input voltage, $V_{ID}$ (see Note 2)	$\pm V_{DD}$
Input voltage, $V_I$ (any input, see Note 1)	-0.3 V to $V_{DD}$
Input current, $I_I$ (any input)	$\pm 5$ mA
Output current, $I_O$	$\pm 50$ mA
Total current into $V_{DD+}$	$\pm 50$ mA
Total current out of $V_{DD-}$	$\pm 50$ mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ : C suffix	0°C to 70°C
I suffix (dual)	-40°C to 85°C
I suffix (quad)	-40°C to 125°C
Q suffix	-40°C to 125°C
M suffix	-55°C to 125°C
Storage temperature range, $T_{stg}$	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between  $V_{DD+}$  and  $V_{DD-}$ .  
 2. Differential voltages are at  $IN+$  with respect to  $IN-$ . Excessive current will flow if input is brought below  $V_{DD-} - 0.3$  V.  
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
D (8)	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW
D (14)	1022 mW	7.6 mW/°C	900 mW	777 mW	450 mW
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
PW (8)	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW
PW (14)	720 mW	5.6 mW/°C	634 mW	547 mW	317 mW
U	675 mW	5.4 mW/°C	432 mW	350 mW	135 mW

**recommended operating conditions**

	C SUFFIX		I SUFFIX		Q SUFFIX		M SUFFIX		UNIT
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, $V_{DD}$	2.7	10	2.7	10	2.7	10	2.7	10	V
Input voltage range, $V_I$	$V_{DD-}$	$V_{DD+} - 1$	$V_{DD-}$	$V_{DD+} - 1$	$V_{DD-}$	$V_{DD+} - 1.3$	$V_{DD-}$	$V_{DD+} - 1.3$	V
Common-mode input voltage, $V_{IC}$	$V_{DD-}$	$V_{DD+} - 1$	$V_{DD-}$	$V_{DD+} - 1$	$V_{DD-} + 2$	$V_{DD+} - 1.3$	$V_{DD-} + 2$	$V_{DD+} - 1.3$	V
Operating free-air temperature, $T_A$	0	70	-40	125	-40	125	-55	125	°C

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2442			UNIT
			MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$	TLV244xC TLV244xI	25°C	300	2000	$\mu\text{V}$
			Full range	2500		
		TLV244xAI	25°C	300	950	
			Full range	1500		
		TLV2442AQ TLV2442AM	25°C	300	950	
			Full range	1600		
$\alpha_{VIO}$ Temperature coefficient of input offset voltage		25°C to 85°C	2		$\mu\text{V}/^\circ\text{C}$	
Input offset voltage long-term drift (see Note 4)		25°C	0.002		$\mu\text{V}/\text{mo}$	
$I_{IO}$ Input offset current		25°C	0.5		$\text{pA}$	
		Full range	150			
$I_{IB}$ Input bias current		25°C	1		$\text{pA}$	
		-40°C to 85°C	150			
		125°C	350			
		TLV2442Q/AQ TLV2442M/AM	Full range	260		
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	25°C	0 to 2.25	-0.25 to 2.5	$\text{V}$	
		Full range	0 to 2			
		25°C to -55°C	0 to 2.25	-0.25 to 2.5		
		125°C	0 to 2			
$V_{OH}$ High-level output voltage	$I_O = -100\ \mu\text{A}$ $I_O = -3\text{ mA}$	25°C	2.98		$\text{V}$	
		25°C	2.5			
		Full range	2.25			
$V_{OL}$ Low-level output voltage	$V_{IC} = 1.5\text{ V}$ , $I_O = 100\ \mu\text{A}$ $V_{IC} = 1.5\text{ V}$ , $I_O = 3\text{ mA}$	25°C	0.02		$\text{V}$	
		25°C	0.63			
		Full range	1			
$A_{VD}$ Large-signal differential voltage amplification	$V_O = 1\text{ V to }2\text{ V}$	$R_L = 600\ \Omega$	25°C	0.7	1	$\text{V/mV}$
			Full range	0.4		
		$R_L = 1\ \text{M}\Omega$	25°C	750		
$r_{id}$ Differential input resistance		25°C	1000		$\text{G}\Omega$	
$r_i$ Common-mode input resistance		25°C	1000		$\text{G}\Omega$	
$c_i$ Common-mode input capacitance	$f = 10\text{ kHz}$	25°C	8		$\text{pF}$	
$z_o$ Closed-loop output impedance	$f = 1\text{ MHz}$ , $A_V = 10$	25°C	130		$\Omega$	

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is -40°C to 85°C. Full range for the quad I suffix is -40°C to 125°C. Full range for the Q suffix is -40°C to 125°C. Full range for the M suffix is -55°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted) (continued)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2442			UNIT
			MIN	TYP	MAX	
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }2.25\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$	25°C	65	75		dB
		Full range	55			
		Full range	50			
$k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD\pm}/\Delta V_{IO}$ )	$V_{DD} = 2.7\text{ V to }8\text{ V}$ , No load $V_{IC} = V_{DD}/2$	25°C	80	95		dB
		Full range	80			
$I_{DD}$ Supply current (per channel)	$V_O = 1.5\text{ V}$ , No load	25°C		725	1100	$\mu\text{A}$
		Full range			1100	

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

**operating characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV244x			UNIT
			MIN	TYP	MAX	
SR Slew rate at unity gain	$V_O = 1\text{ V to }2\text{ V}$ , $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$	25°C	0.65	1.3		$\text{V}/\mu\text{s}$
		Full range	0.65			
		Full range	0.4			
$V_n$ Equivalent input noise voltage	$f = 10\text{ Hz}$	25°C		170		$\text{nV}/\sqrt{\text{Hz}}$
	$f = 1\text{ kHz}$	25°C		18		
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz to }1\text{ Hz}$	25°C		2.6		$\mu\text{V}$
	$f = 0.1\text{ Hz to }10\text{ Hz}$	25°C		5.1		
$I_n$ Equivalent input noise current		25°C		0.6		$\text{fA}/\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O = 0.5\text{ V to }2.5\text{ V}$ , $R_L = 600\ \Omega$ , $f = 1\text{ kHz}$	25°C	$A_V = 1$	0.08%		
			$A_V = 10$	0.3%		
			$A_V = 100$	2%		
Gain-bandwidth product	$f = 10\text{ kHz}$ , $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$	25°C		1.75		MHz
BOM Maximum output-swing bandwidth	$V_{O(PP)} = 1\text{ V}$ , $A_V = 1$ , $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$	25°C		0.9		MHz
$t_s$ Settling time	$A_V = -1$ , Step = –2.3 V to 2.3 V, $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$	25°C	To 0.1%	1.5		$\mu\text{s}$
			To 0.01%	3.2		
$\phi_m$ Phase margin at unity gain	$R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$	25°C		65°		
Gain margin		25°C		9		dB

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV244x			UNIT	
			MIN	TYP	MAX		
$V_{IO}$ Input offset voltage		TLV244xC	25°C	300	2000	$\mu\text{V}$	
		TLV244xI	Full range		2500		
		TLV244xA	25°C	300	950		
			Full range		1500		
		TLV2442AQ	25°C	300	950		
		TLV2442AM	Full range		1600		
$\alpha_{VIO}$ Temperature coefficient of input offset voltage		25°C to 85°C		2		$\mu\text{V}/^\circ\text{C}$	
Input offset voltage long-term drift (see Note 4)	$V_{DD\pm} = \pm 2.5\text{ V}$ , $V_O = 0$ , $V_{IC} = 0$ , $R_S = 50\ \Omega$	25°C		0.002		$\mu\text{V}/\text{mo}$	
$I_{IO}$ Input offset current		25°C		0.5		$\text{pA}$	
		Full range			150		
$I_{IB}$ Input bias current		25°C		1		$\text{pA}$	
		-40°C to 85°C			150		
		125°C			350		
		TLV2442Q/AQ TLV2442M/AM	Full range				260
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	25°C	0 to 4.25	-0.25 to 4.5		V	
		Full range	0 to 4				
$V_{OH}$ High-level output voltage	$I_{OH} = -100\ \mu\text{A}$	25°C		4.97		V	
	$I_{OH} = -5\text{ mA}$	25°C		4	4.35		
		Full range			4		
$V_{OL}$ Low-level output voltage	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 100\ \mu\text{A}$	25°C		0.01		V	
	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 5\text{ mA}$	25°C		0.8			
		Full range					1.25
$A_{VD}$ Large-signal differential voltage amplification	$V_{IC} = 2.5\text{ V}$ , $V_O = 1\text{ V to }4\text{ V}$	$R_L = 600\ \Omega$ ‡	25°C	0.9	1.3	V/mV	
		$R_L = 1\text{ M}\Omega$ ‡	Full range		0.5		
			25°C				950
$r_{id}$ Differential input resistance		25°C		1000		G $\Omega$	
$r_i$ Common-mode input resistance		25°C		1000		G $\Omega$	
$c_i$ Common-mode input capacitance	$f = 10\text{ kHz}$	25°C		8		pF	
$z_o$ Closed-loop output impedance	$f = 1\text{ MHz}$ , $A_V = 10$	25°C		140		$\Omega$	
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }4.25\text{ V}$ , $V_O = 2.5\text{ V}$ , $R_S = 50\ \Omega$	25°C		70	75	dB	
		Full range		70			

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is -40°C to 85°C. Full range for the quad I suffix is -40°C to 125°C. Full range for the Q suffix is -40°C to 125°C. Full range for the M suffix is -55°C to 125°C.

‡ Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted) (continued)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV244x			UNIT
			MIN	TYP	MAX	
$k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ )	$V_{DD} = 4.4\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load	25°C	80	95		dB
		Full range	80			
$I_{DD}$ Supply current (per channel)	$V_O = 2.5\text{ V}$ , No load	25°C		750	1100	$\mu\text{A}$
		Full range			1100	

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

**operating characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV244x			UNIT
			MIN	TYP	MAX	
SR Slew rate at unity gain	$V_O = 0.5\text{ V to }2.5\text{ V}$ , $R_L = 600\ \Omega^\ddagger$ , $C_L = 100\ \text{pF}^\ddagger$	25°C	0.75	1.4		$\text{V}/\mu\text{s}$
		Full range	0.75			
		Full range	0.5			
$V_n$ Equivalent input noise voltage	$f = 10\text{ Hz}$	25°C		130		$\text{nV}/\sqrt{\text{Hz}}$
		25°C		16		
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz to }1\text{ Hz}$	25°C		1.8		$\mu\text{V}$
		25°C		3.6		
$I_n$ Equivalent input noise current		25°C		0.6		$\text{fA}/\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O = 1.5\text{ V to }3.5\text{ V}$ , $f = 1\text{ kHz}$ , $R_L = 600\ \Omega^\ddagger$	25°C	$A_V = 1$	0.017%		
			$A_V = 10$	0.17%		
			$A_V = 100$	1.5%		
Gain-bandwidth product	$f = 10\text{ kHz}$ , $R_L = 600\ \Omega^\ddagger$ , $C_L = 100\ \text{pF}^\ddagger$	25°C		1.81		MHz
BOM Maximum output-swing bandwidth	$V_{O(PP)} = 2\text{ V}$ , $A_V = 1$ , $R_L = 600\ \Omega^\ddagger$ , $C_L = 100\ \text{pF}^\ddagger$	25°C		0.5		MHz
$t_s$ Settling time	$A_V = -1$ , Step = 0.5 V to 2.5 V, $R_L = 600\ \Omega^\ddagger$ , $C_L = 100\ \text{pF}^\ddagger$	25°C	To 0.1%	1.5		$\mu\text{s}$
			To 0.01%	2.6		
$\phi_m$ Phase margin at unity gain	$R_L = 600\ \Omega^\ddagger$ , $C_L = 100\ \text{pF}^\ddagger$	25°C		68°		
Gain margin		25°C		8		dB

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

‡ Referenced to 2.5 V



**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**TYPICAL CHARACTERISTICS**

**Table of Graphs†**

		FIGURE
$V_{IO}$	Input offset voltage	Distribution vs Common-mode voltage 2, 3 4, 5
$\alpha_{VIO}$	Input offset voltage temperature coefficient	Distribution 6, 7
$I_{IB}/I_{IO}$	Input bias and input offset currents	vs Free-air temperature 8
$V_{OH}$	High-level output voltage	vs High-level output current 9, 10
$V_{OL}$	Low-level output voltage	vs Low-level output current 11, 12
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency 13
$I_{OS}$	Short-circuit output current	vs Supply voltage vs Free-air temperature 14 15
$V_O$	Output voltage	vs Differential Input voltage 16, 17
$A_{VD}$	Differential voltage amplification	vs Load resistance 18
$A_{VD}$	Large-signal differential voltage amplification	vs Frequency vs Free-air temperature 19, 20 21, 22
$z_o$	Output impedance	vs Frequency 23, 24
CMRR	Common-mode rejection ratio	vs Frequency vs Free-air temperature 25 26
$k_{SVR}$	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature 27, 28 29
$I_{DD}$	Supply current	vs Supply voltage 30
SR	Slew rate	vs Load capacitance vs Free-air temperature 31 32
$V_O$	Inverting large-signal pulse response	33, 34
	Voltage-follower large-signal pulse response	35, 36
	Inverting small-signal pulse response	37, 38
	Voltage-follower small-signal pulse response	39, 40
$V_n$	Equivalent input noise voltage	vs Frequency 41, 42
	Noise voltage	Over a 10-second period 43
THD + N	Total harmonic distortion plus noise	vs Frequency 44, 45
	Gain-bandwidth product	vs Free-air temperature vs Supply voltage 46 47
$\phi_m$	Phase margin	vs Frequency vs Load capacitance 19, 20 48
	Gain margin	vs Load capacitance 49
$B_1$	Unity-gain bandwidth	vs Load capacitance 50

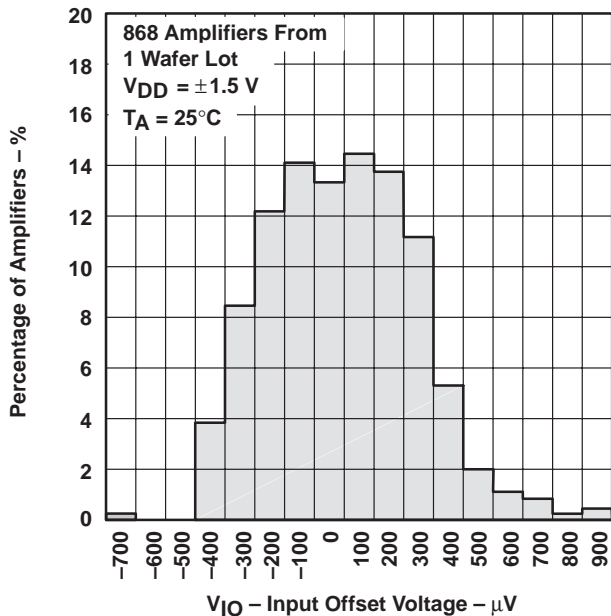
† For all graphs where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

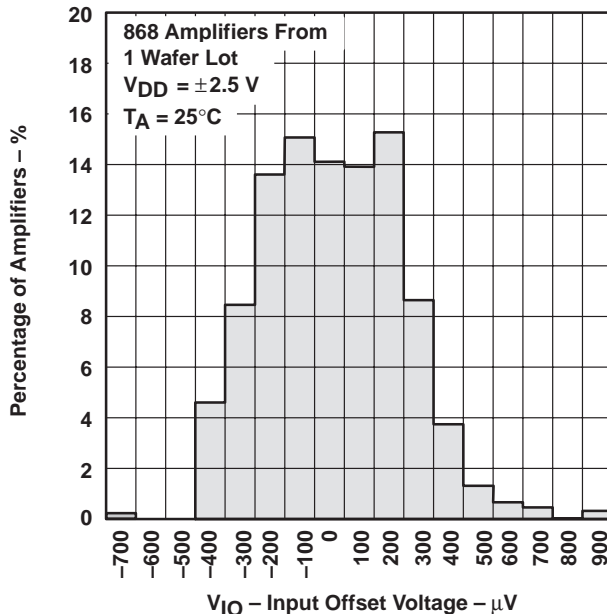
**TYPICAL CHARACTERISTICS**

**DISTRIBUTION OF TLV2442  
 INPUT OFFSET VOLTAGE**



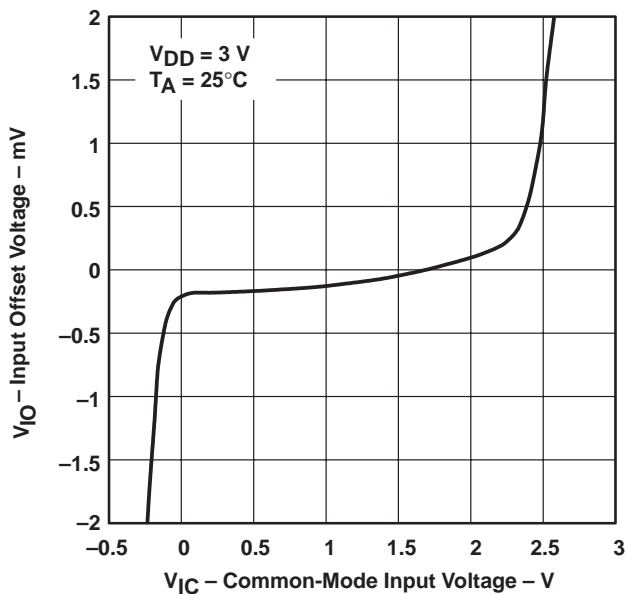
**Figure 2**

**DISTRIBUTION OF TLV2442  
 INPUT OFFSET VOLTAGE**



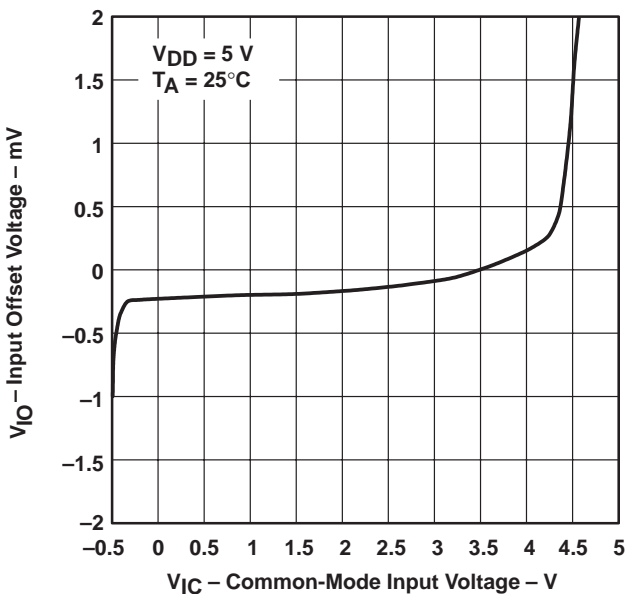
**Figure 3**

**INPUT OFFSET VOLTAGE  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 4**

**INPUT OFFSET VOLTAGE  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 5**

TYPICAL CHARACTERISTICS

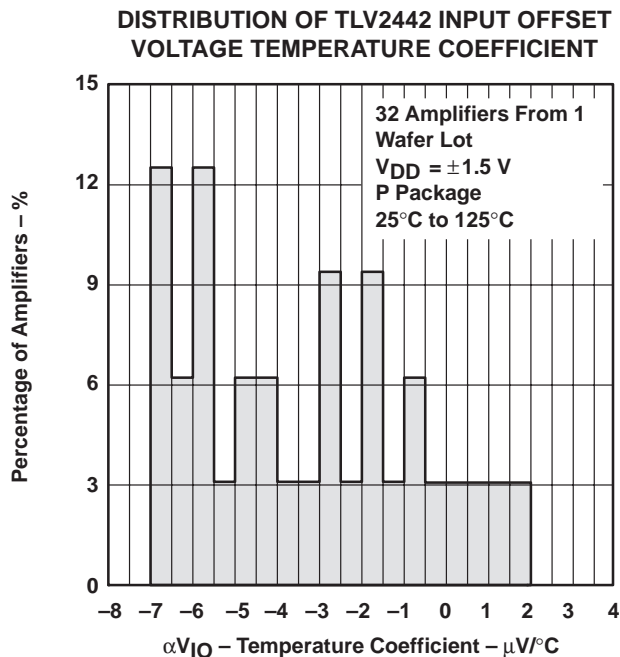


Figure 6

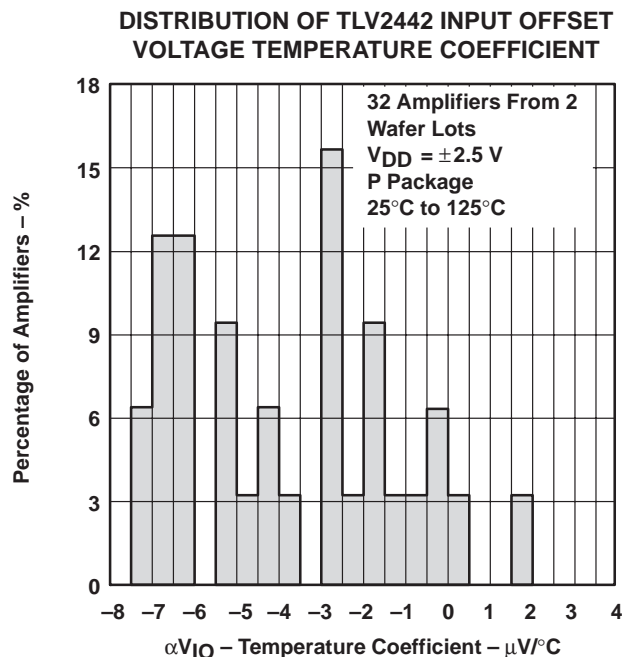


Figure 7

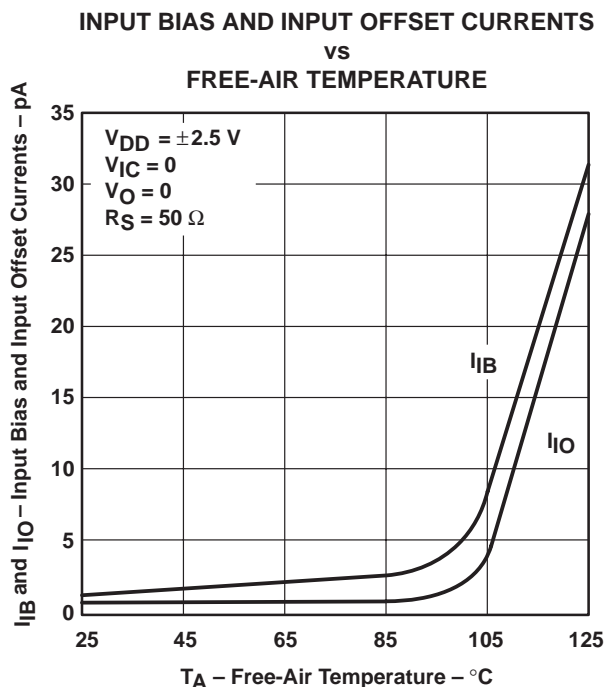


Figure 8

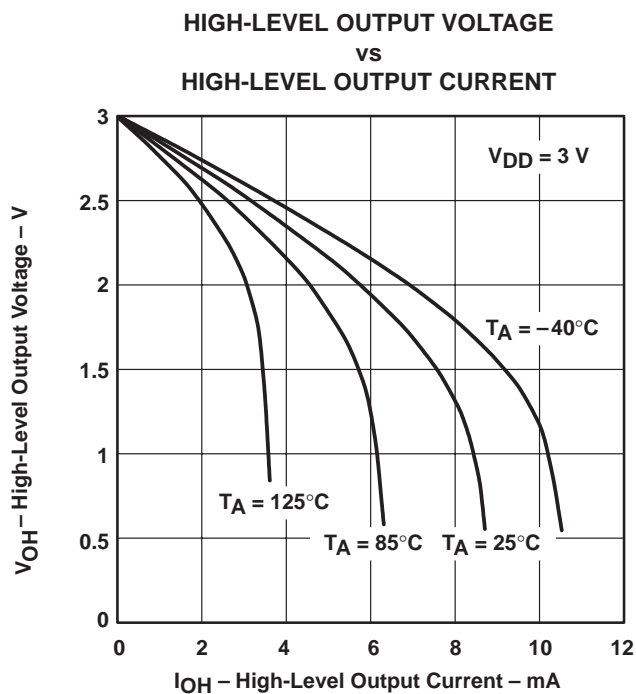
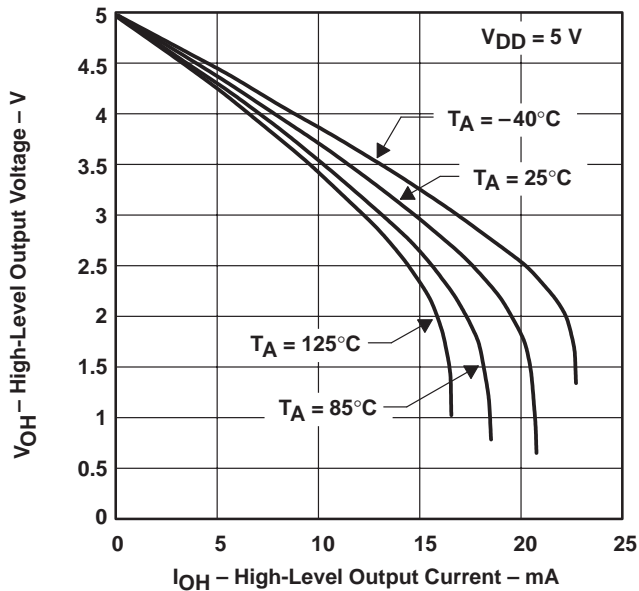


Figure 9

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

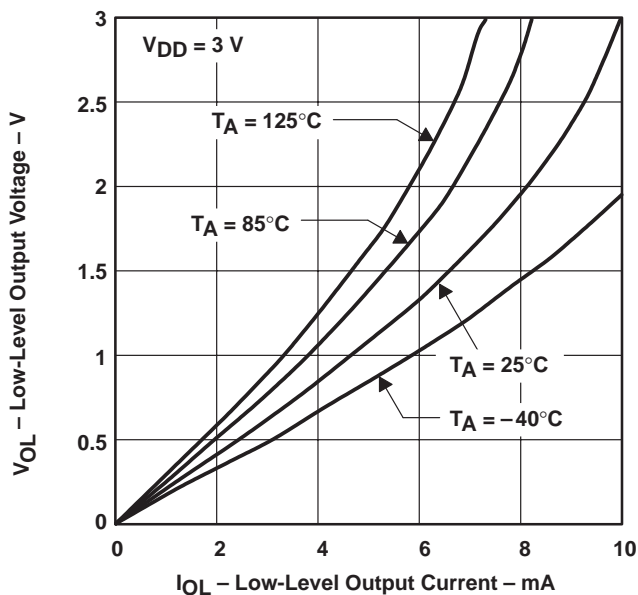
**TYPICAL CHARACTERISTICS**

**HIGH-LEVEL OUTPUT VOLTAGE  
 vs  
 HIGH-LEVEL OUTPUT CURRENT**



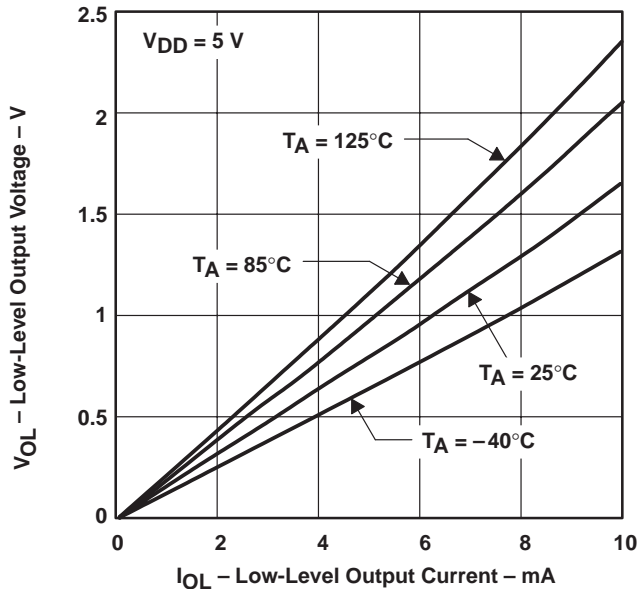
**Figure 10**

**LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT**



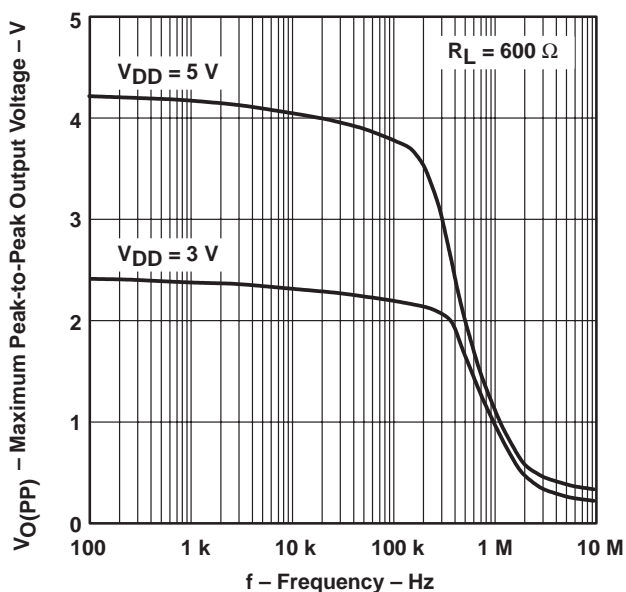
**Figure 11**

**LOW-LEVEL OUTPUT VOLTAGE  
 vs  
 LOW-LEVEL OUTPUT CURRENT**



**Figure 12**

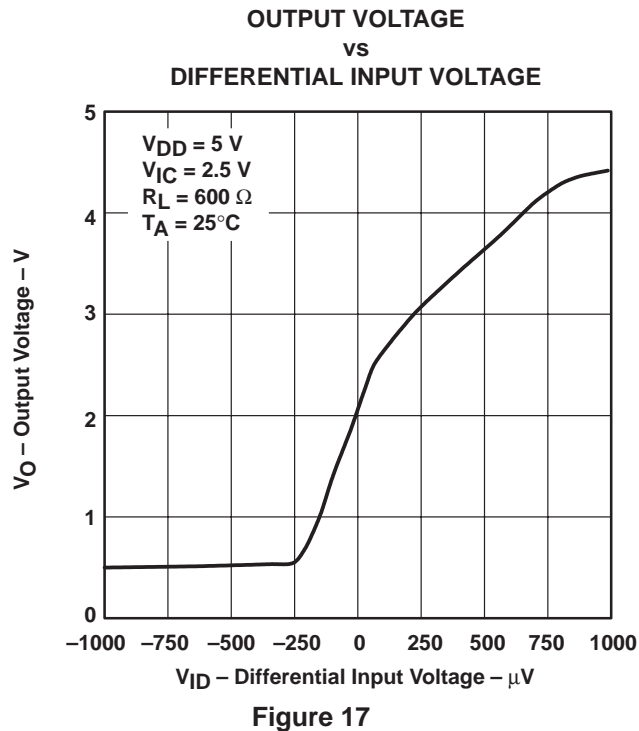
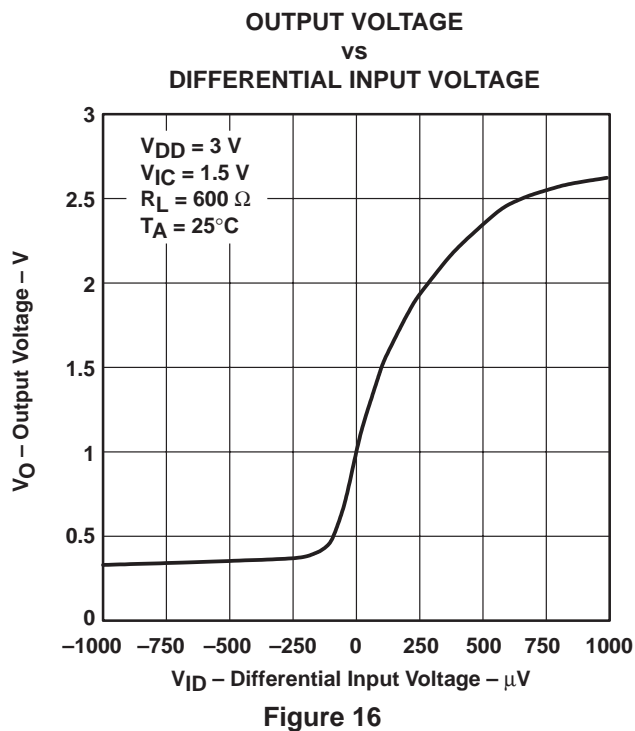
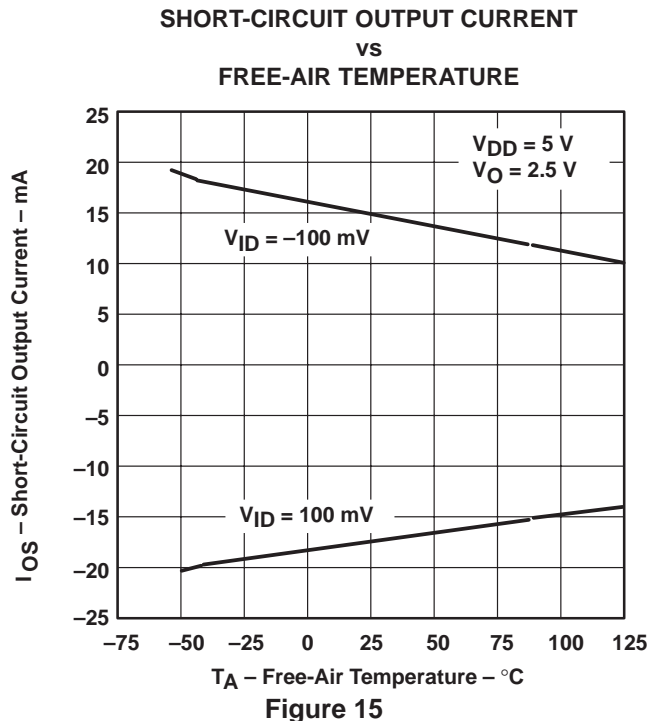
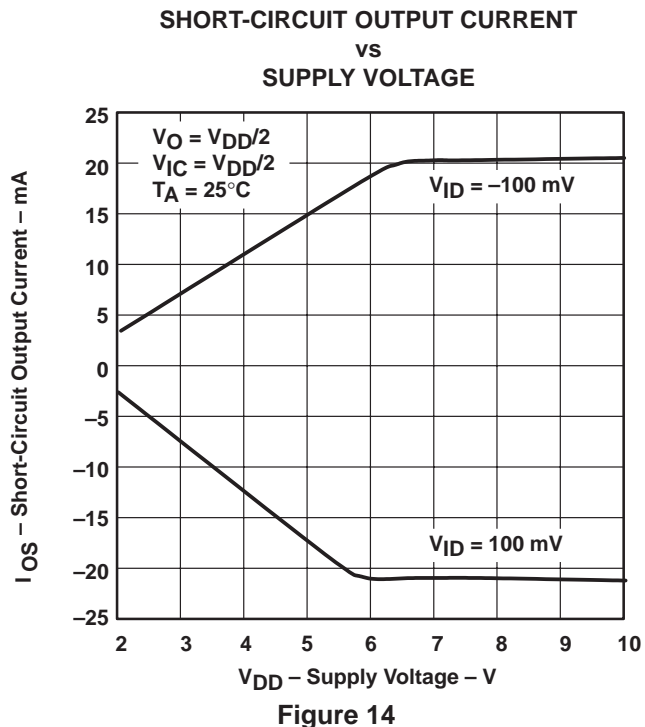
**MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE  
 vs  
 FREQUENCY**



**Figure 13**

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**TYPICAL CHARACTERISTICS**



TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

TYPICAL CHARACTERISTICS

DIFFERENTIAL VOLTAGE AMPLIFICATION  
 vs  
 LOAD RESISTANCE

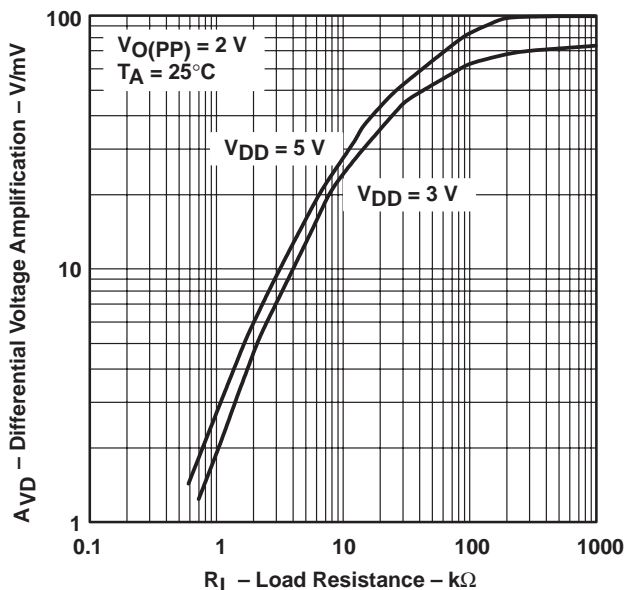


Figure 18

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN  
 vs  
 FREQUENCY

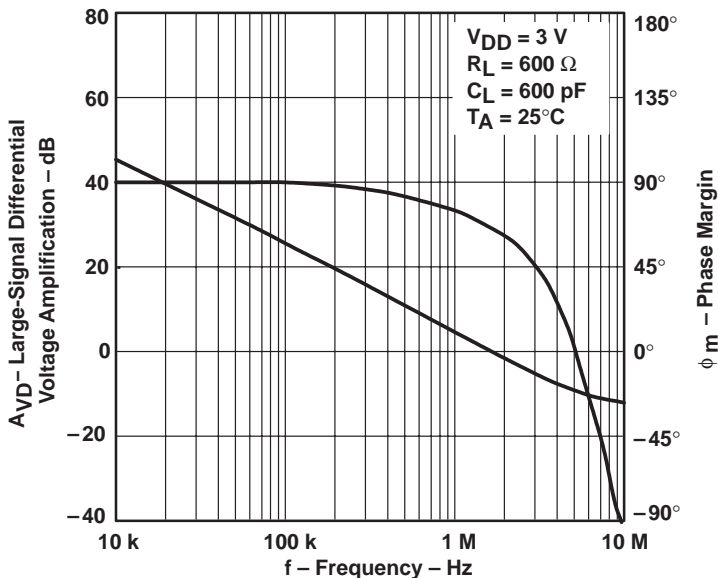


Figure 19

TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN  
 VS  
 FREQUENCY

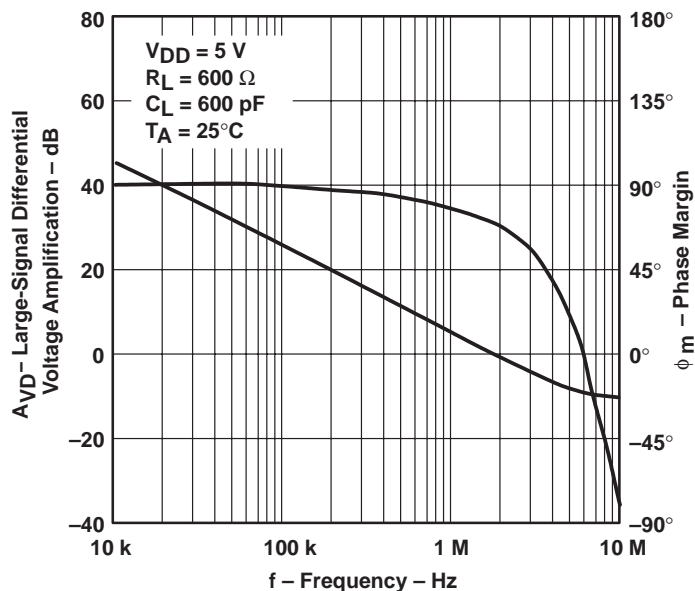


Figure 20

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION  
 VS  
 FREE-AIR TEMPERATURE

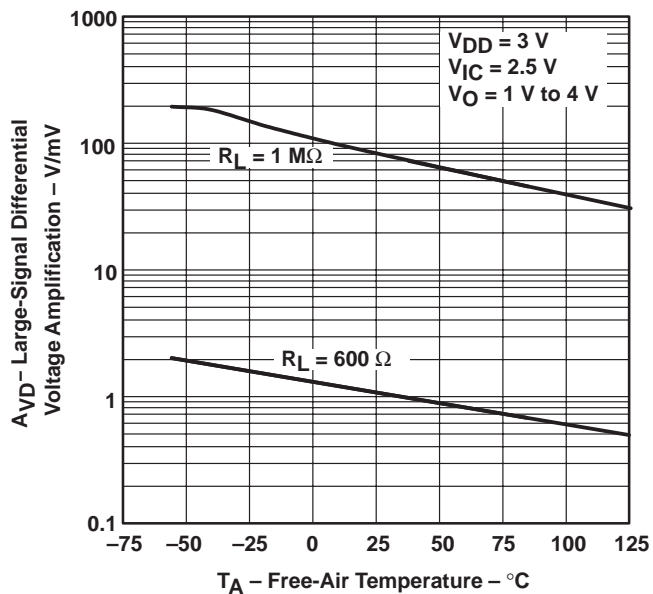


Figure 21

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION  
 VS  
 FREE-AIR TEMPERATURE

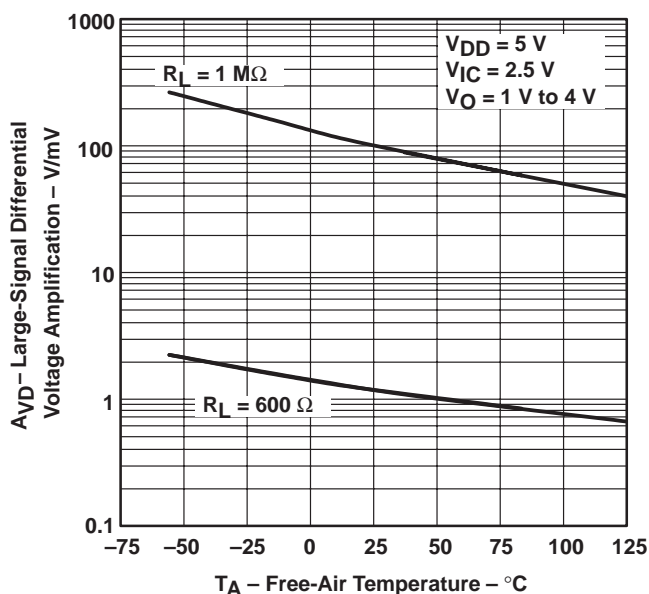
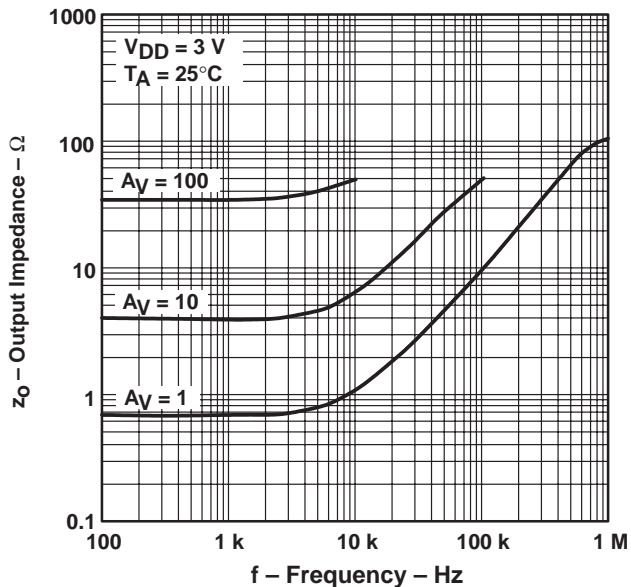


Figure 22

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

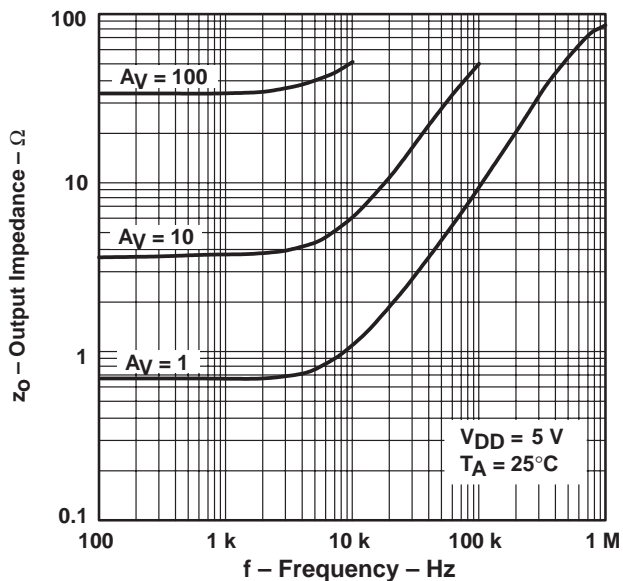
**TYPICAL CHARACTERISTICS**

**OUTPUT IMPEDANCE  
vs  
FREQUENCY**



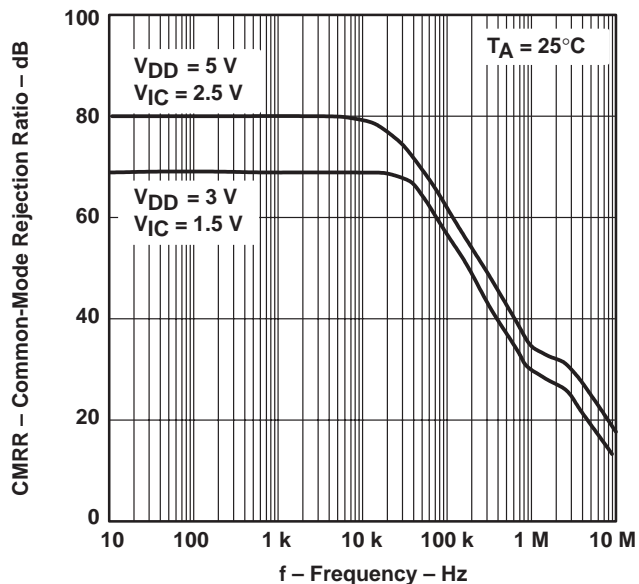
**Figure 23**

**OUTPUT IMPEDANCE  
vs  
FREQUENCY**



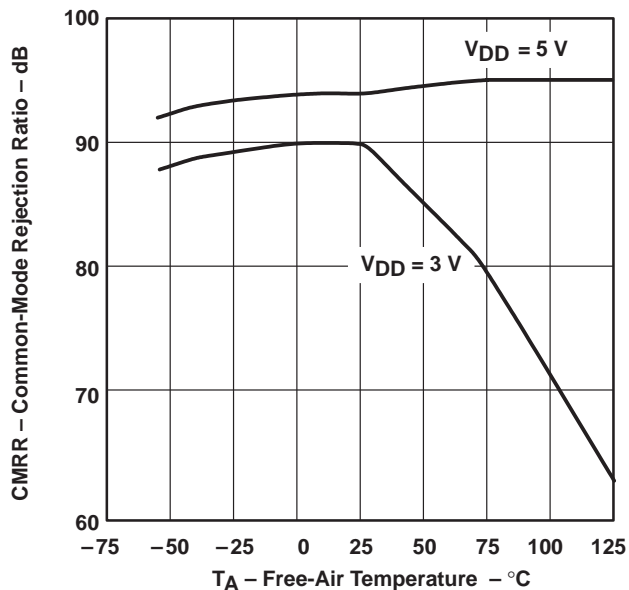
**Figure 24**

**COMMON-MODE REJECTION RATIO  
vs  
FREQUENCY**



**Figure 25**

**COMMON-MODE REJECTION RATIO  
vs  
FREE-AIR TEMPERATURE**



**Figure 26**



TYPICAL CHARACTERISTICS

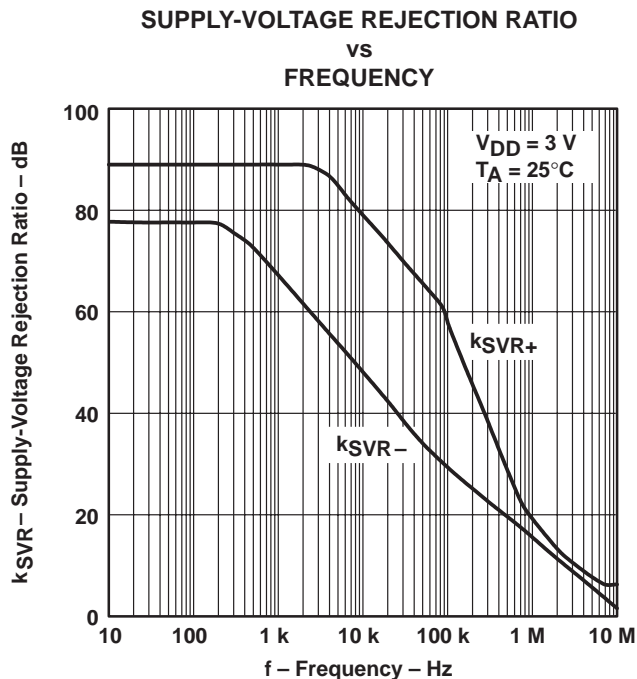


Figure 27

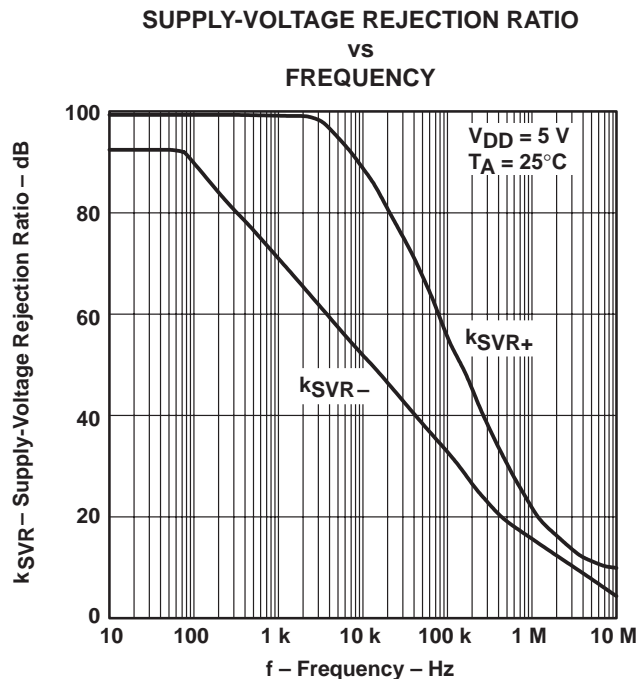


Figure 28

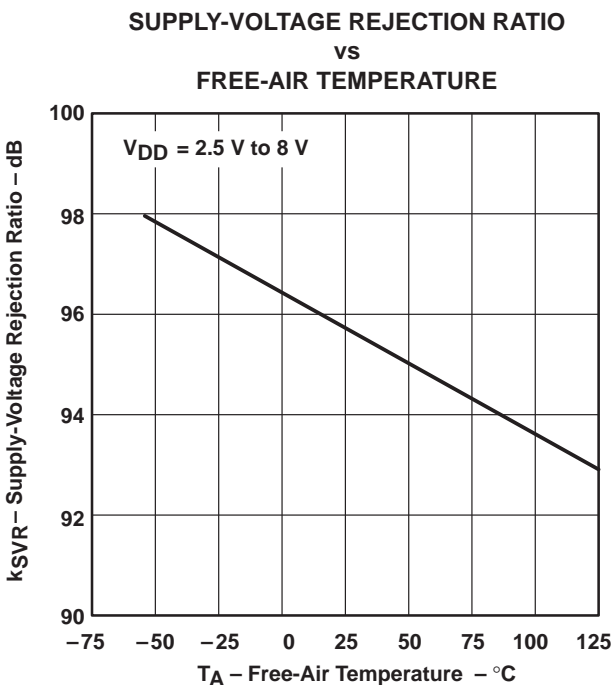


Figure 29

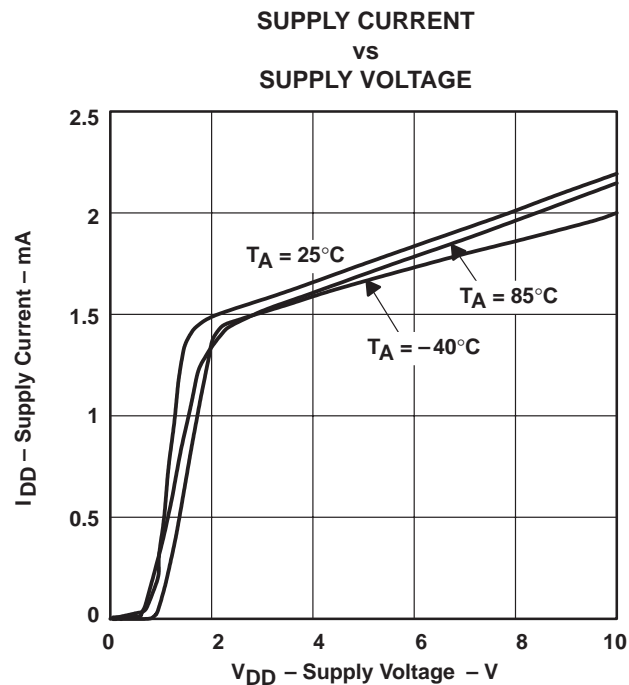
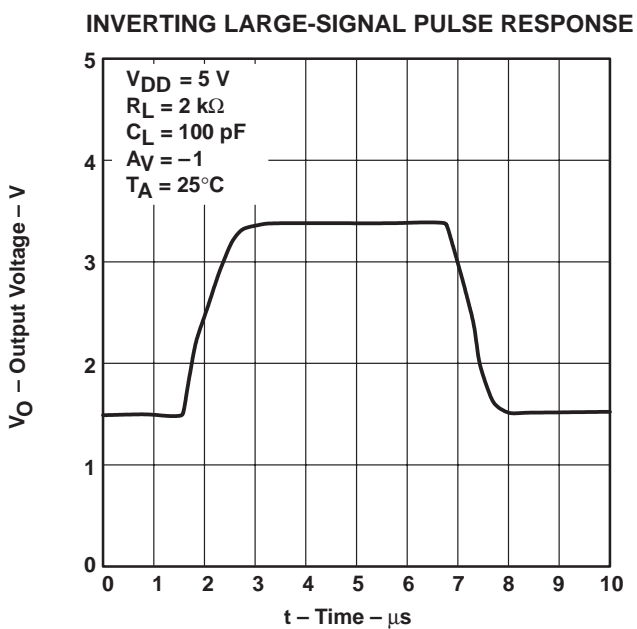
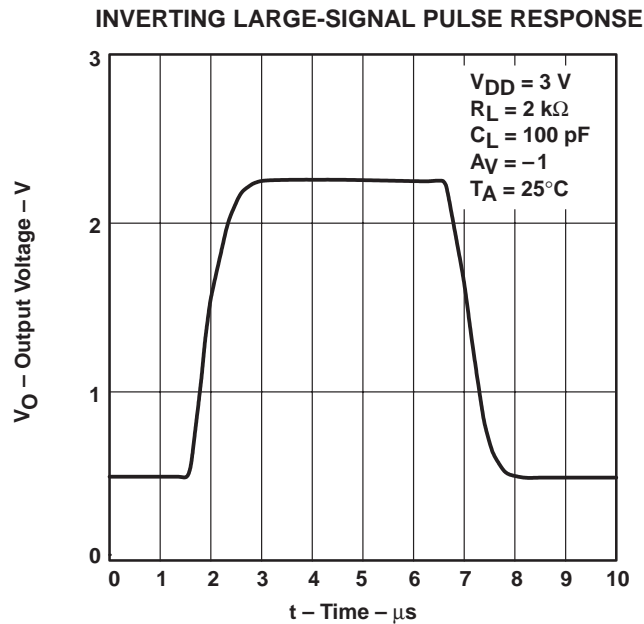
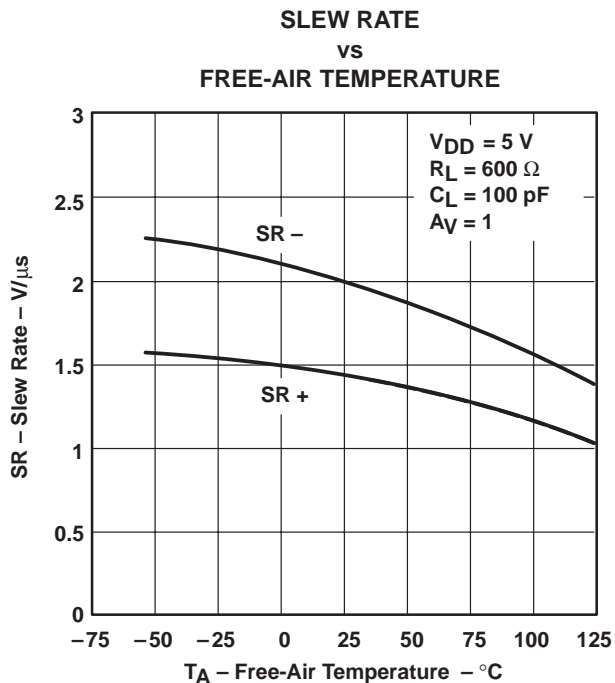
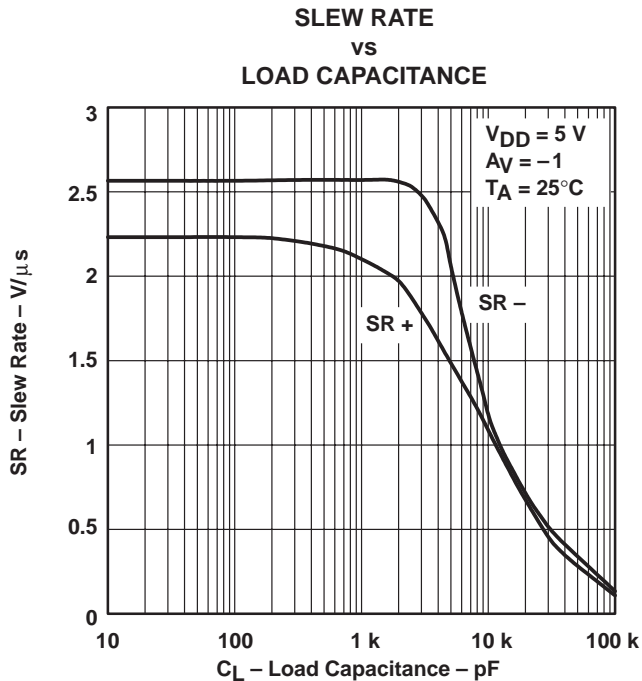


Figure 30

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**TYPICAL CHARACTERISTICS**



TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

TYPICAL CHARACTERISTICS

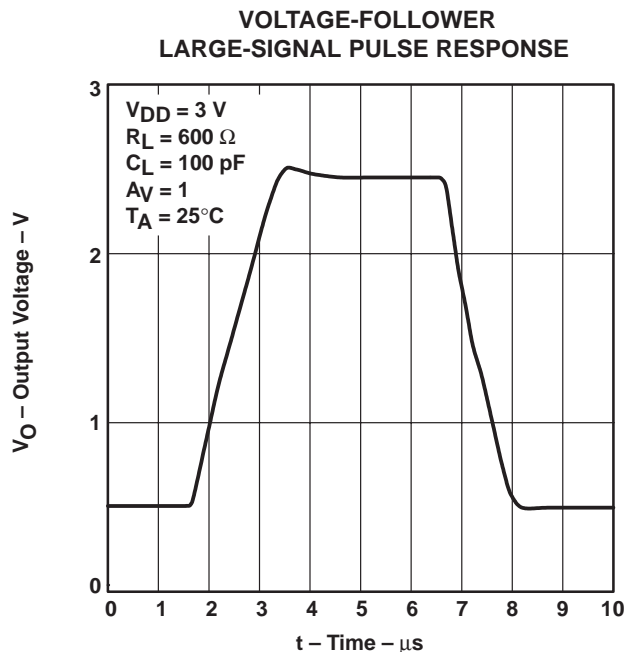


Figure 35

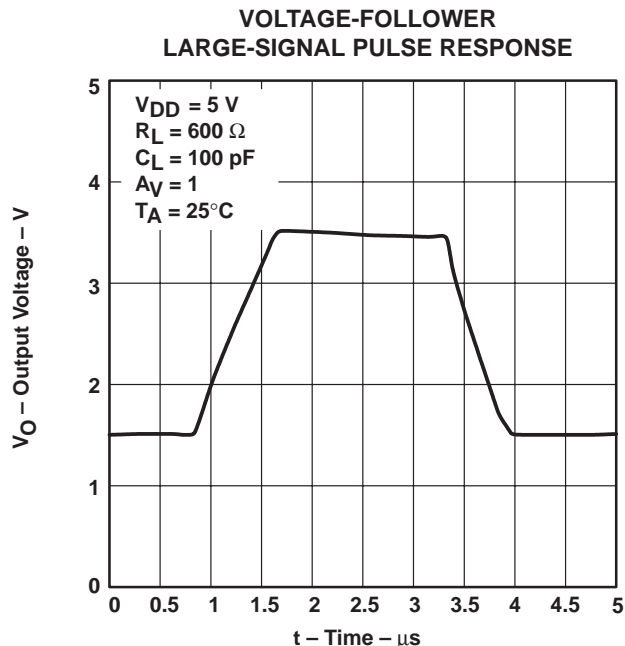


Figure 36

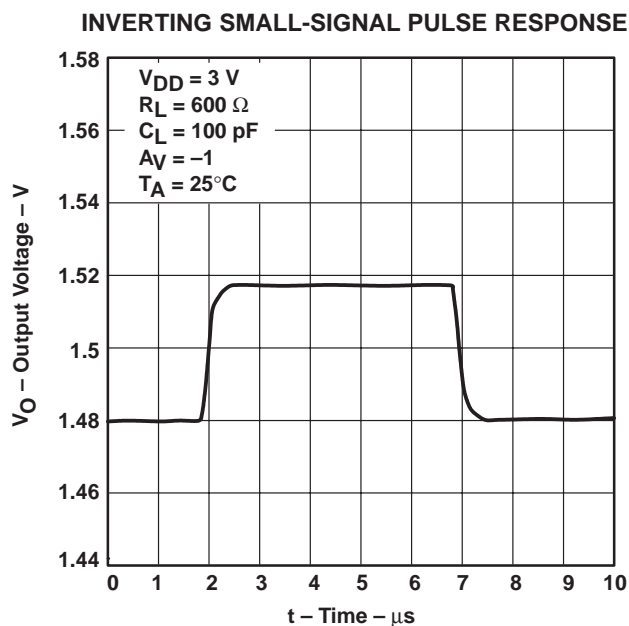


Figure 37

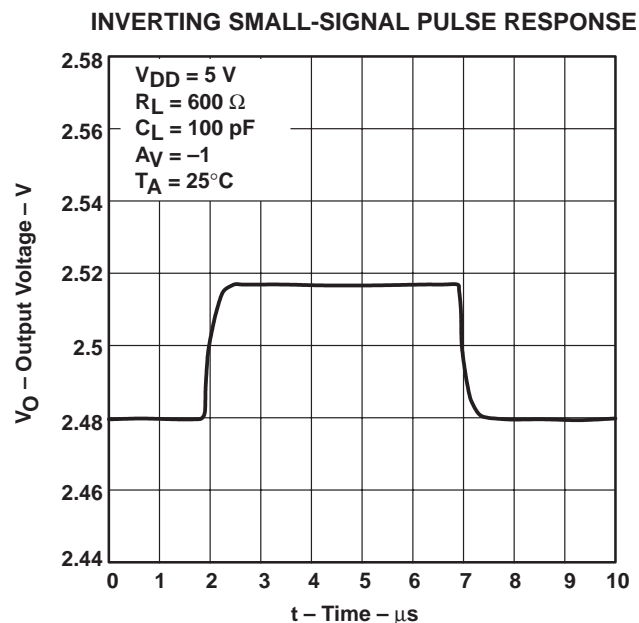
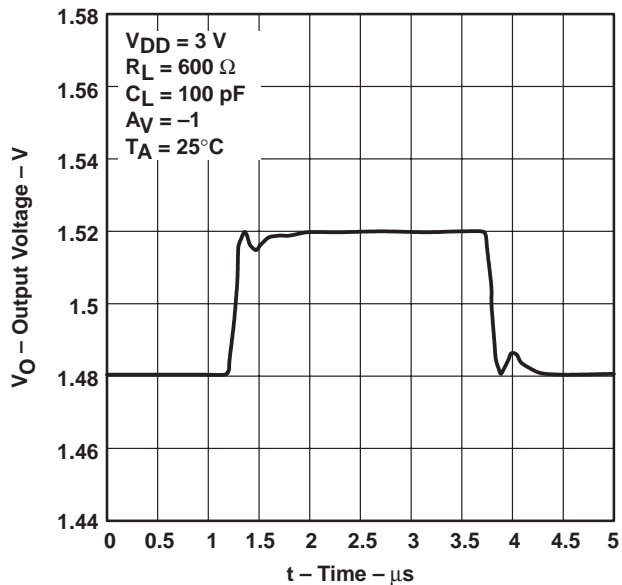


Figure 38

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

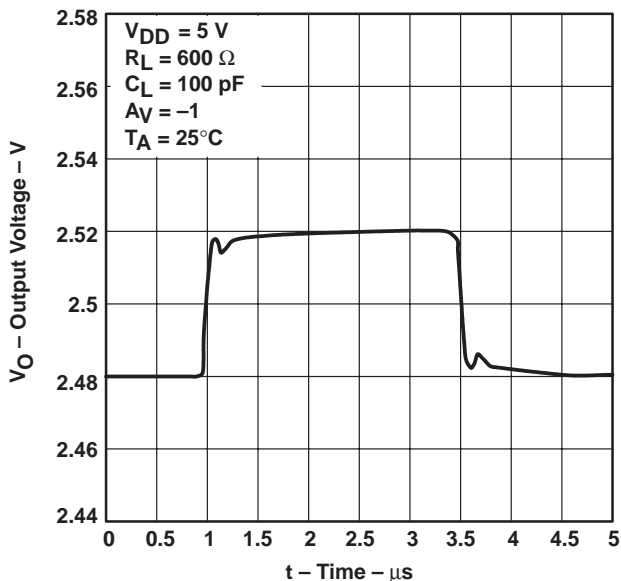
**TYPICAL CHARACTERISTICS**

**VOLTAGE-FOLLOWER  
 SMALL-SIGNAL PULSE RESPONSE**



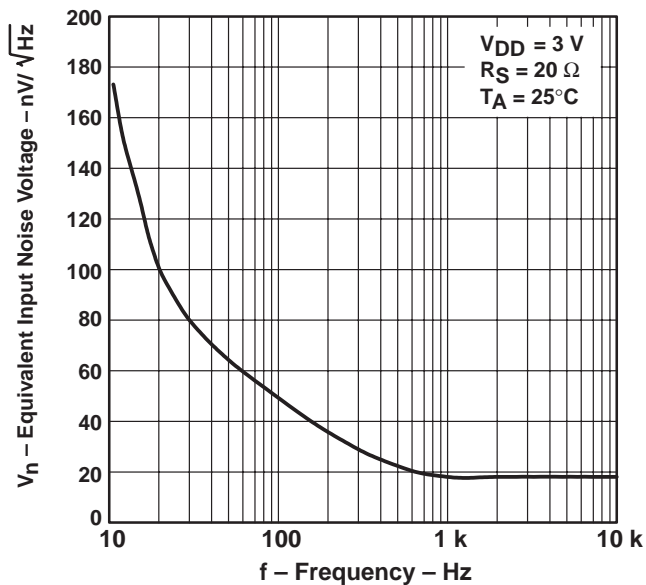
**Figure 39**

**VOLTAGE-FOLLOWER  
 SMALL-SIGNAL PULSE RESPONSE**



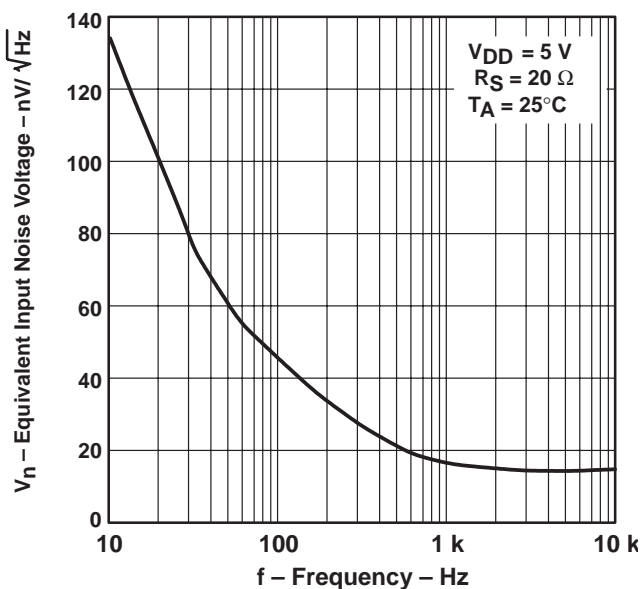
**Figure 40**

**EQUIVALENT INPUT NOISE VOLTAGE  
 vs  
 FREQUENCY**



**Figure 41**

**EQUIVALENT INPUT NOISE VOLTAGE  
 vs  
 FREQUENCY**



**Figure 42**

TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

TYPICAL CHARACTERISTICS

NOISE VOLTAGE  
 OVER A 10-SECOND PERIOD

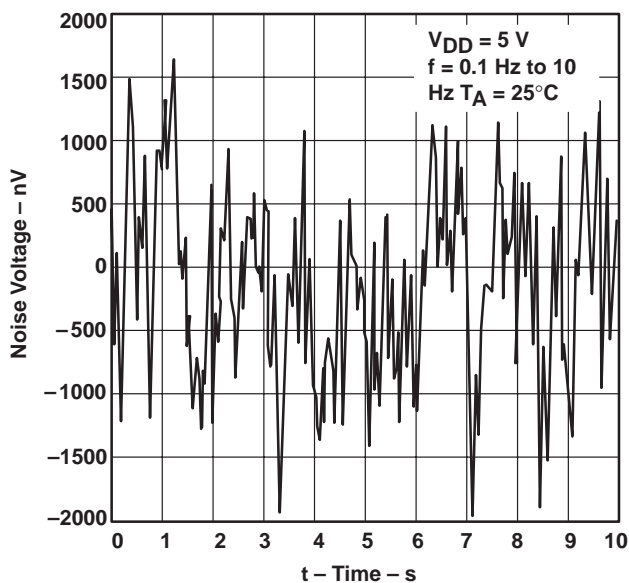


Figure 43

TOTAL HARMONIC DISTORTION PLUS NOISE  
 vs  
 FREQUENCY

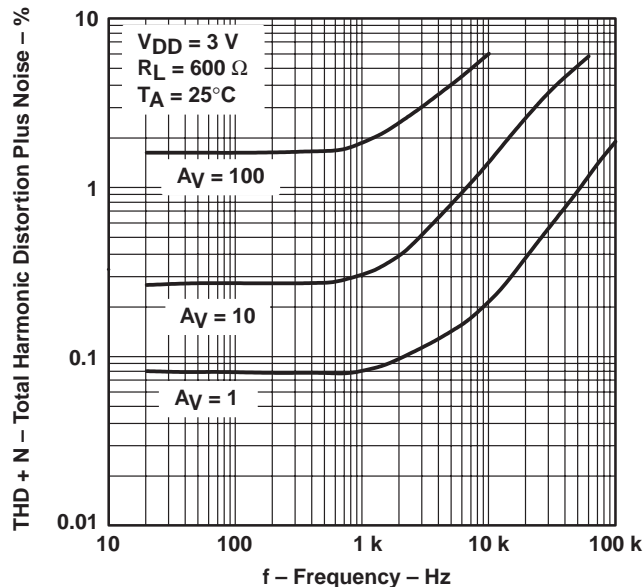


Figure 44

TOTAL HARMONIC DISTORTION PLUS NOISE  
 vs  
 FREQUENCY

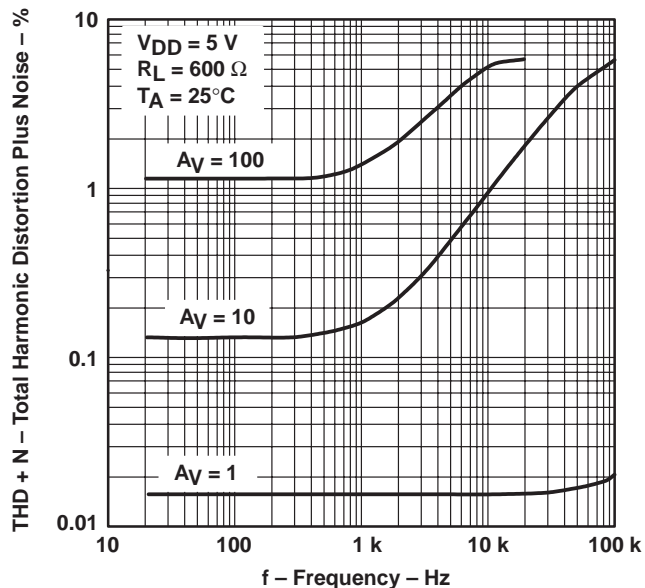


Figure 45

GAIN-BANDWIDTH PRODUCT  
 vs  
 FREE-AIR TEMPERATURE

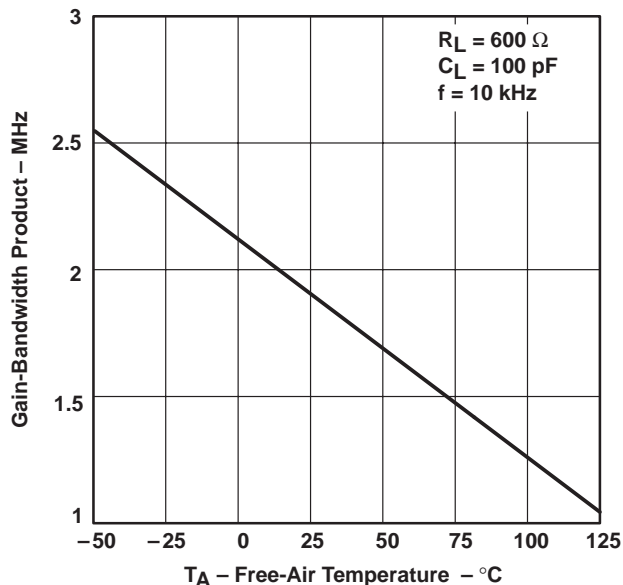


Figure 46

TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

TYPICAL CHARACTERISTICS

GAIN-BANDWIDTH PRODUCT  
 vs  
 SUPPLY VOLTAGE

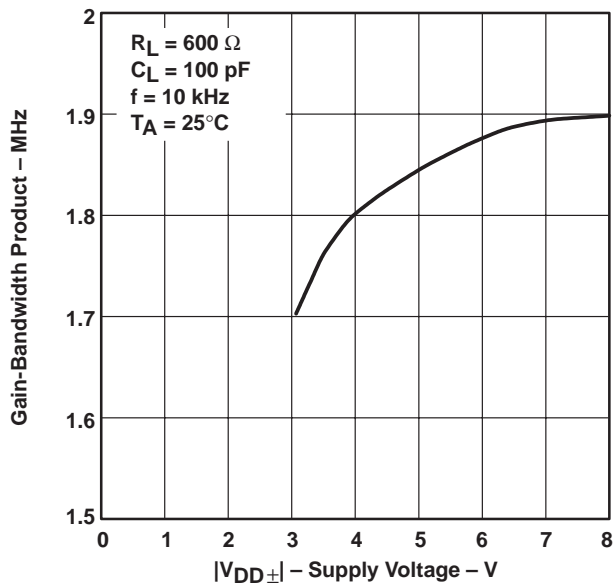


Figure 47

PHASE MARGIN  
 vs  
 LOAD CAPACITANCE

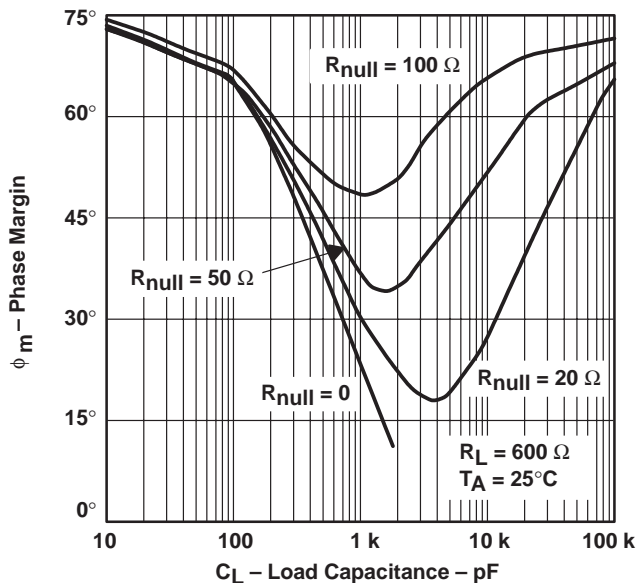


Figure 48

GAIN MARGIN  
 vs  
 LOAD CAPACITANCE

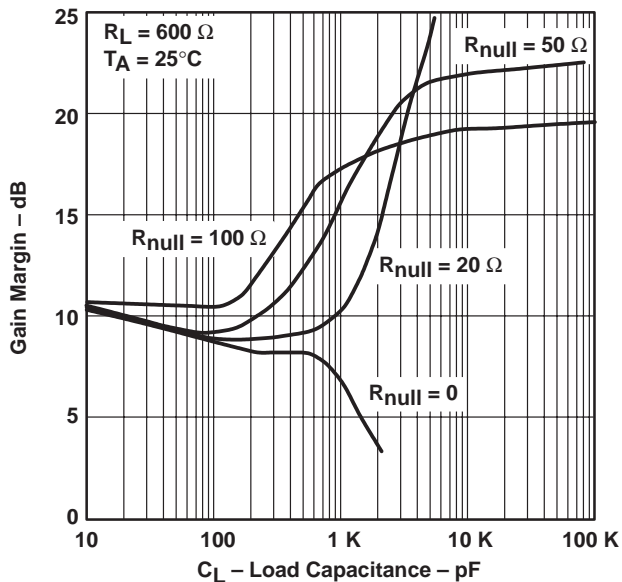


Figure 49

UNITY-GAIN BANDWIDTH  
 vs  
 LOAD CAPACITANCE

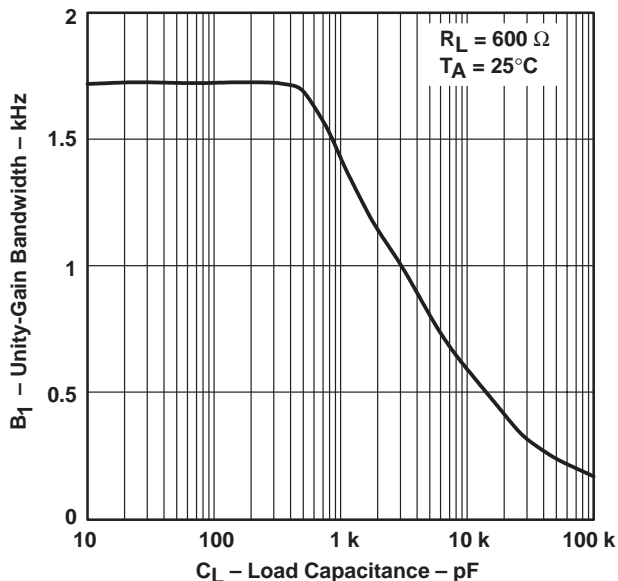


Figure 50

# TLV2442, TLV2442A, TLV2444, TLV2444A Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

## APPLICATION INFORMATION

### macromodel information

Macromodel information provided was derived using *PSpice™ Parts™* model generation software. The Boyle macromodel (see Note 5) and subcircuit in Figure 51 were generated using the TLV244x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 5: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

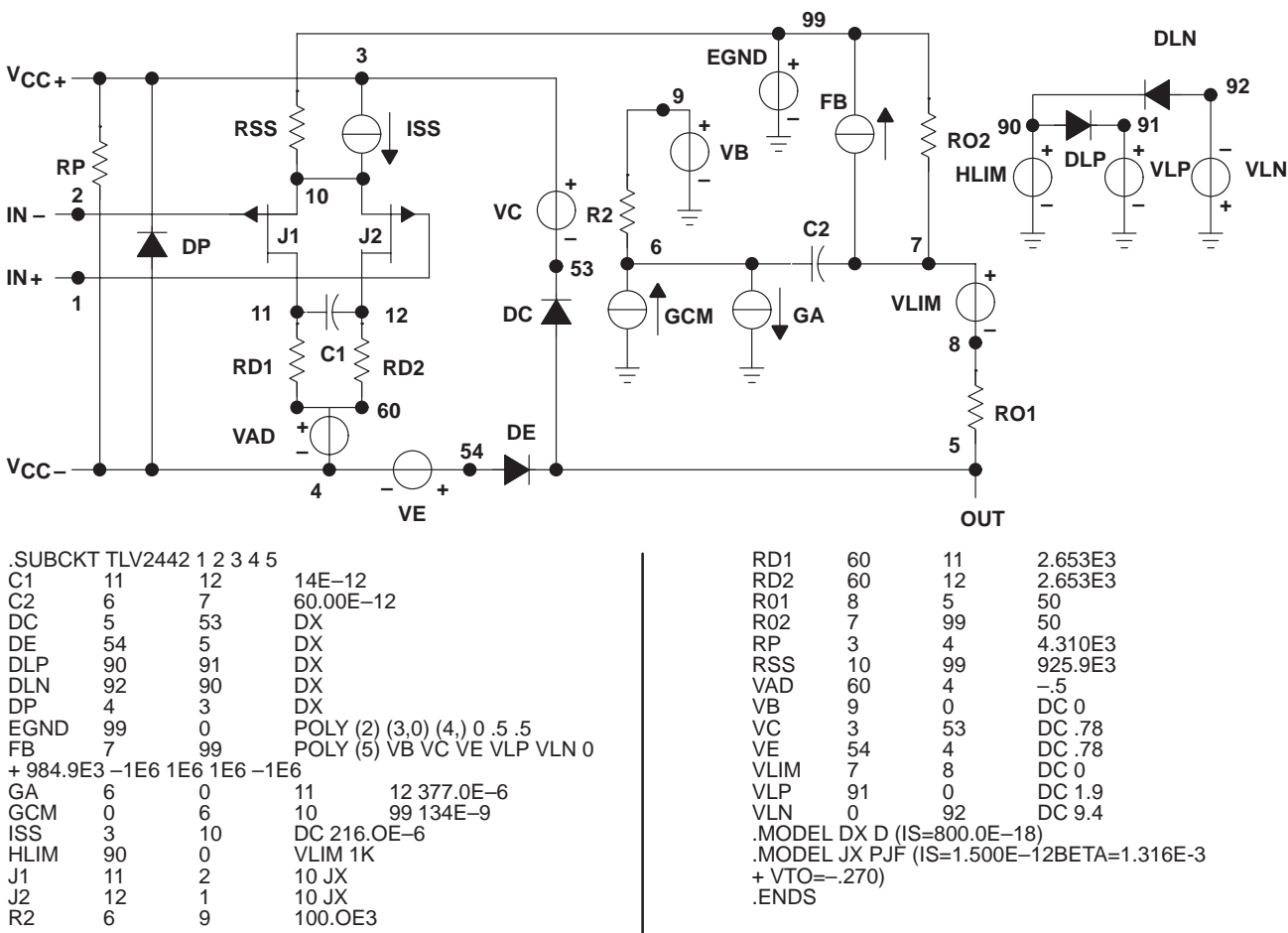


Figure 51. Boyle Macromodel and Subcircuit

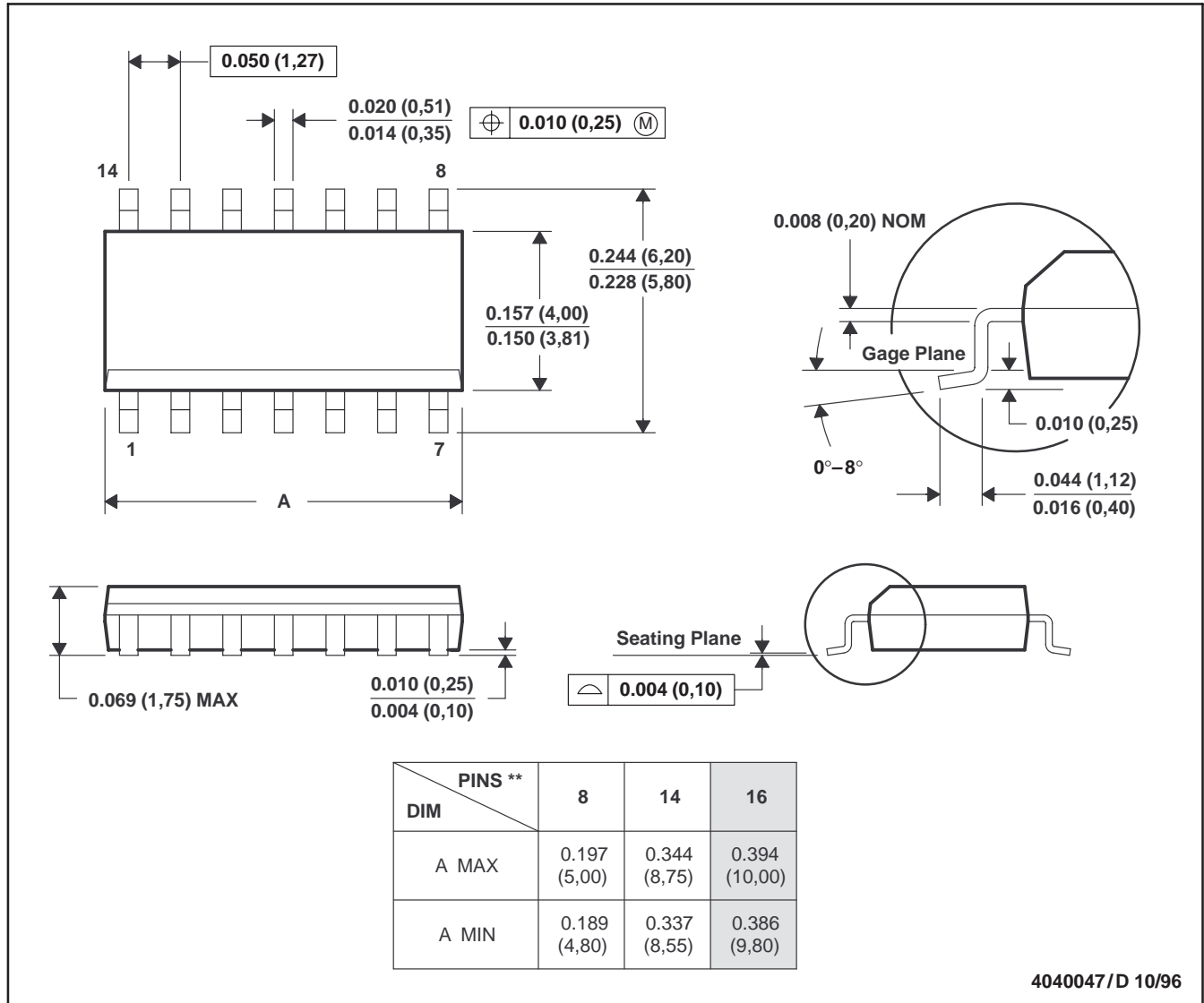
**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**  
 SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**MECHANICAL DATA**

**D (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN



4040047/D 10/96

- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012



TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

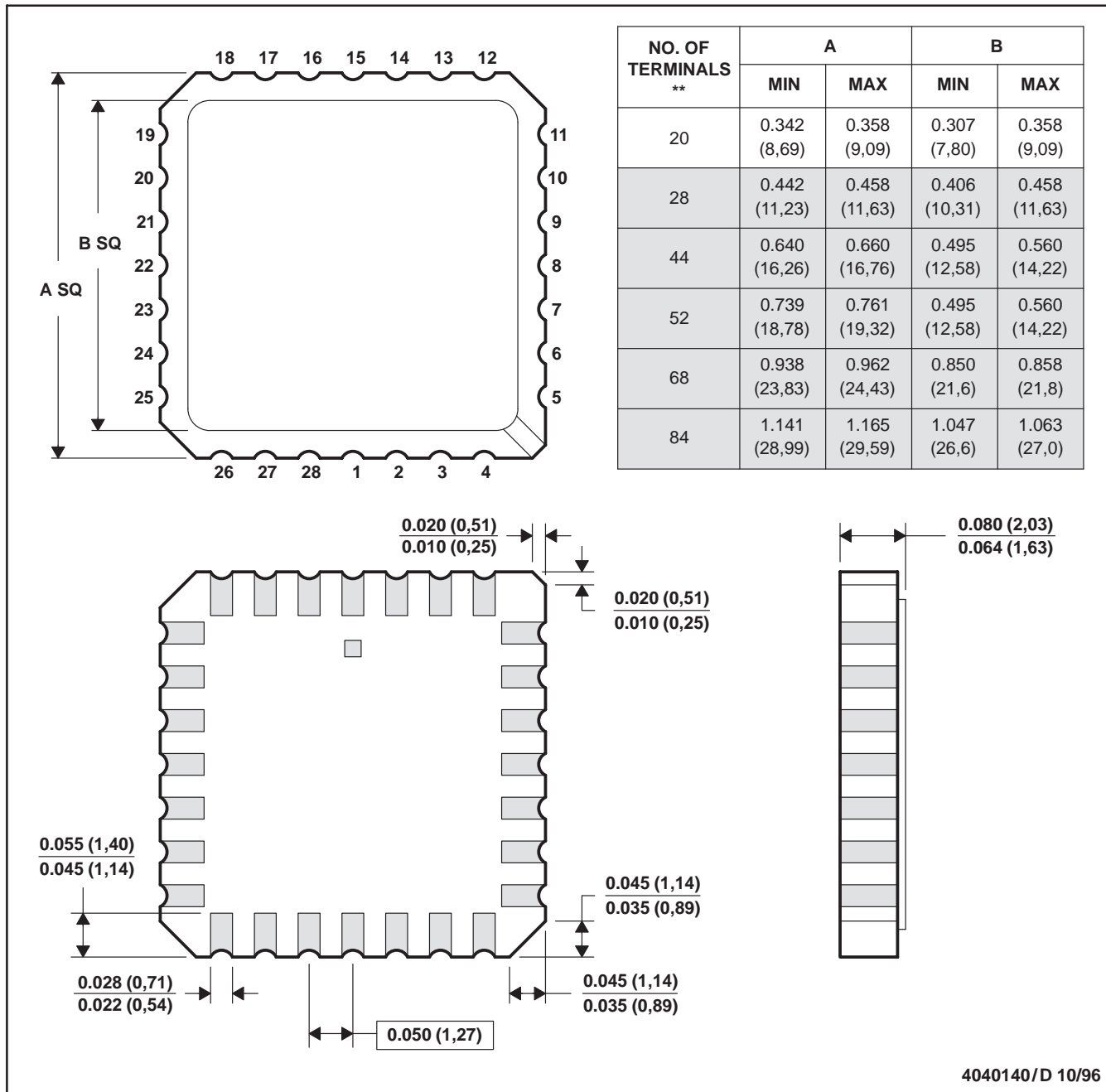
SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

MECHANICAL DATA

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a metal lid.  
 D. The terminals are gold plated.  
 E. Falls within JEDEC MS-004

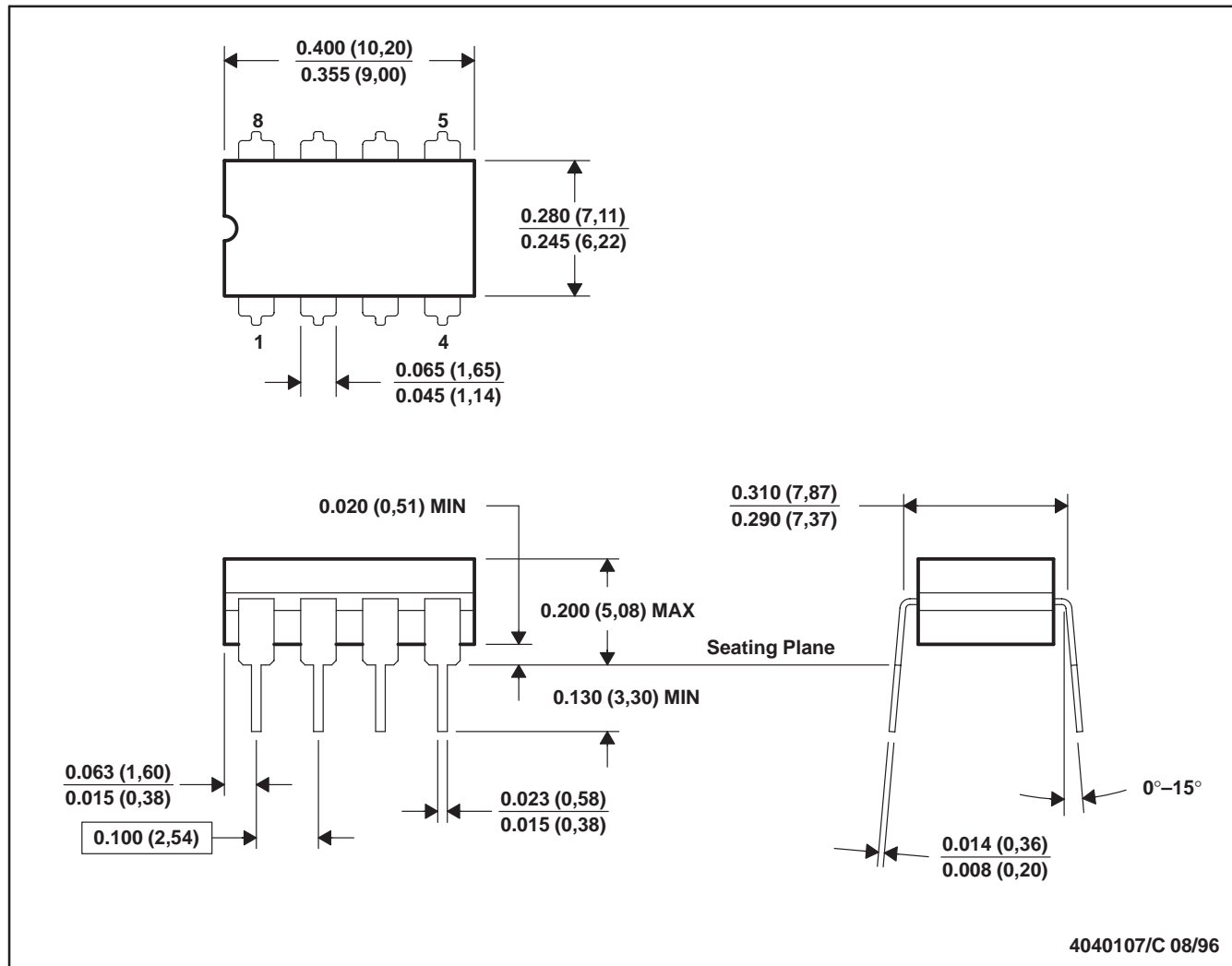
**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**MECHANICAL DATA**

**JG (R-GDIP-T8)**

**CERAMIC DUAL-IN-LINE PACKAGE**



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.  
 E. Falls within MIL-STD-1835 GDIP1-T8

TLV2442, TLV2442A, TLV2444, TLV2444A  
 Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT  
 WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

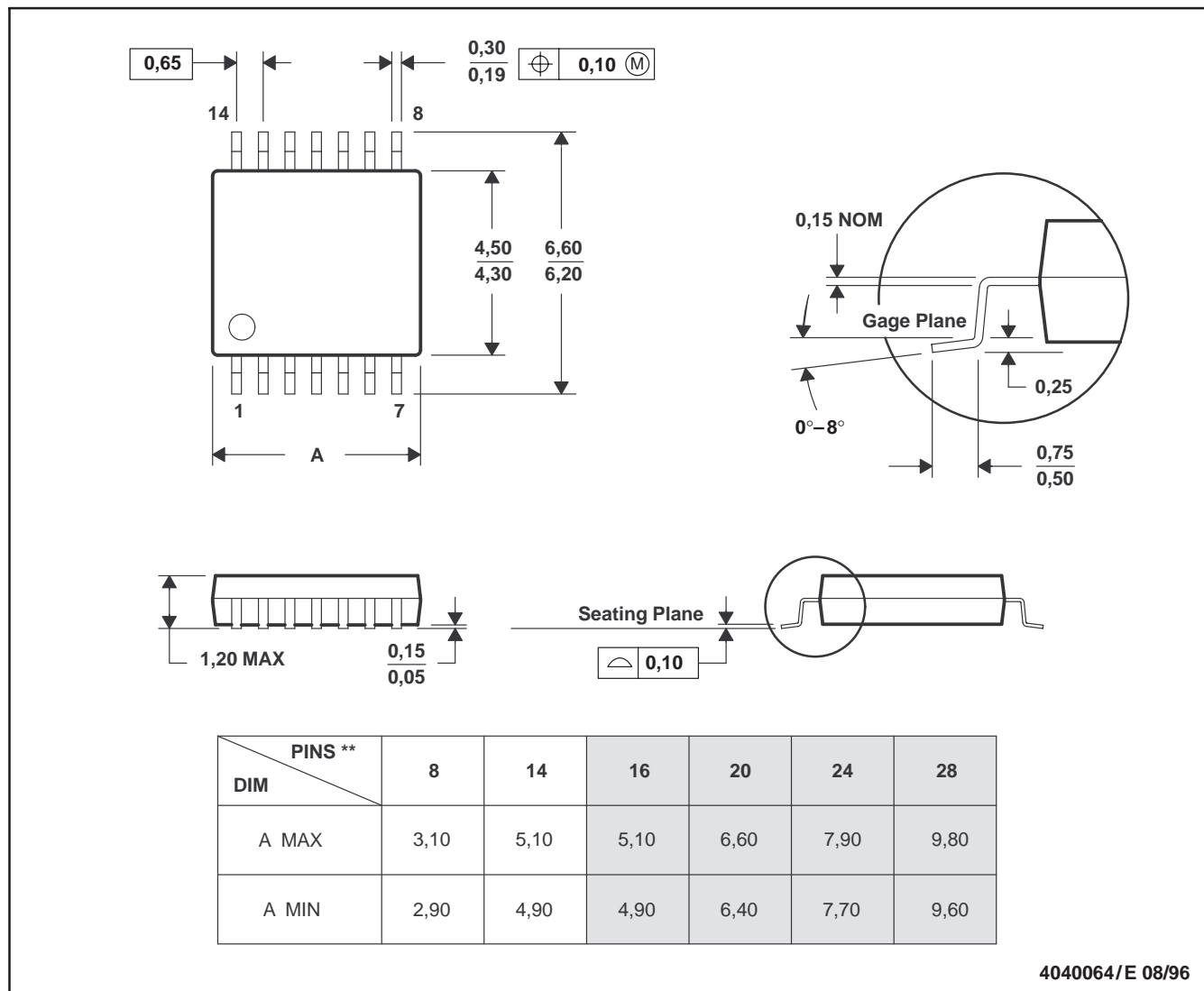
SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

MECHANICAL DATA

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



4040064/E 08/96

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

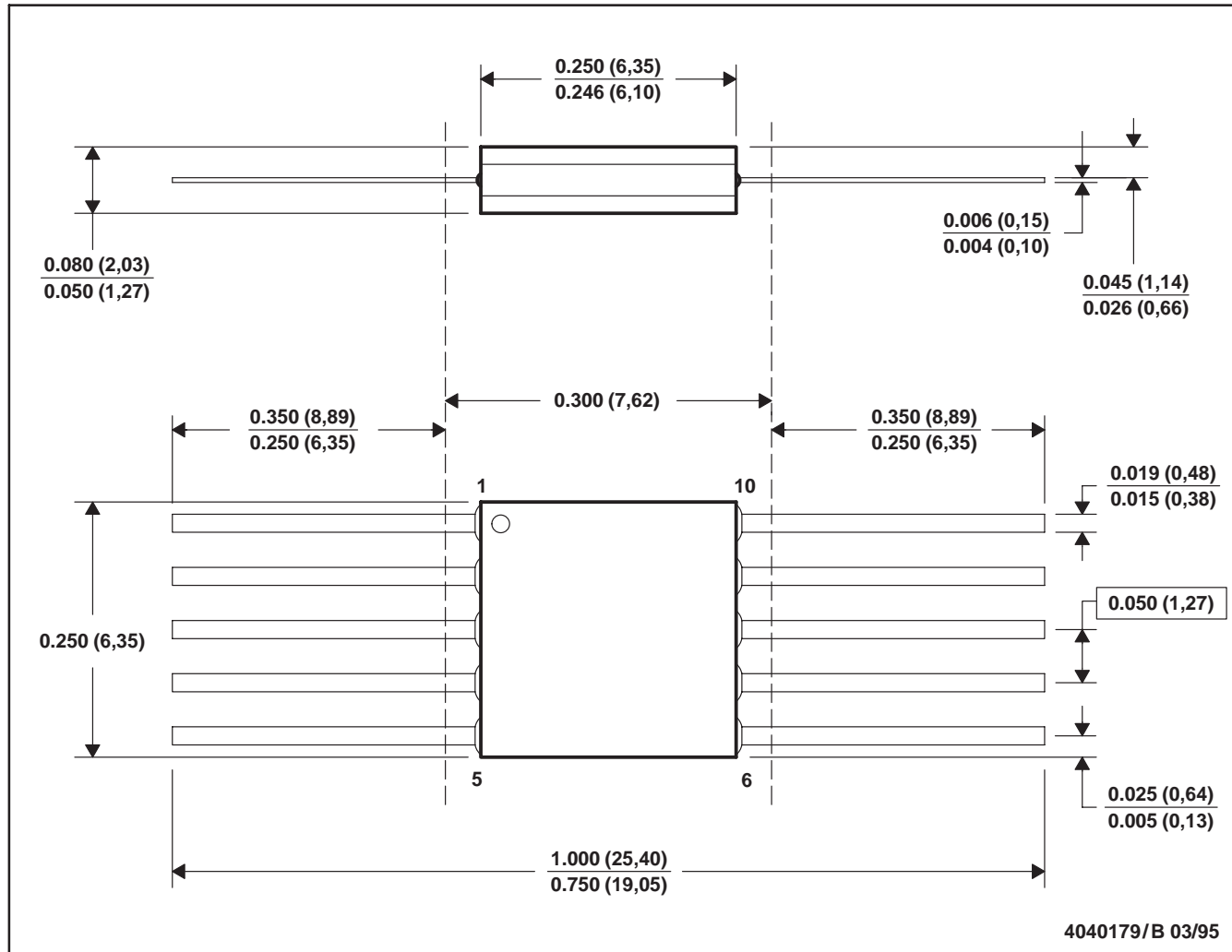
**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

**MECHANICAL DATA**

**U (S-GDFP-F10)**

**CERAMIC DUAL FLATPACK**



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only.  
 E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

## **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

**CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.**

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.